

2nd Gen Intel[®] Xeon[®] Scalable Processors

Specification Update

October 2023

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Revision History

Date	Revision	Description		
October 2023	028	Updated erratum CLX68.		
April 2023	027	Added erratum CLX75.		
September 2022	026	Added erratum CLX74.		
August 2022	025	Added erratum CLX73.		
July 2022	024	Added erratum CLX72.		
June 2022	023	Added errata CLX70., CLX71.		
April 2022	022	Added errata CLX66., CLX67., CLX68., CLX69. Updated "Nomenclature" on page 7		
March 2022	021	Added errata CLX64., CLX65.		
December 2021	020	Added new errata CLX60., CLX61., CLX62., CLX63. Updated CLX55.		
July 2021	019	Added new erratum CLX59.		
June 2021	018	Added new erratum CLX58.		
May 2021	017	Added new erratum CLX57.		
April 2021	016	Added new errata CLX55. and CLX56.		
March 2021	NA	Out of cycle.		
February 2021	015	Added new erratum CLX54.		
January 2021	014	Added new errata CLX47., CLX48., CLX49., CLX50., CLX51., CLX52., and CLX53.		
December 2020	NA	Dut of cycle.		
November 2020	NA	Dut of cycle.		
October 2020	NA	Out of cycle.		
September 2020	012/013	Added new erratum CLX46.		
July 2020	011	Added new erratum CLX45.		
June 2020	010	Added new errata CLX43. and CLX44. Out of cycle.		
May 2020	009	Added new erratum CLX42. Made little fixes about title "Base" in column on figures 14 and 15.		
April 2020	008	Added new errata CLX41. Added new section "Refresh Processors - Non Intel® AVX, Intel® AVX, and Intel® AVX- 512 Turbo Frequencies" on page 20 Added New Turbo Frequencies to Refresh Processors Figure 13, "2nd Gen Intel® Xeon® Scalable Processors Non Intel® AVX Turbo Frequencies" on page 20 Added New Turbo Frequencies to Refresh Processors Figure 14, " 2nd Gen Intel® Xeon® Scalable Processors Intel® AVX 2.0 Turbo Frequencies" on page 21 Added New Turbo Frequencies to Refresh Processors Figure 15, " 2nd Gen Intel® Xeon® Scalable Processors Intel® AVX 512 Turbo Frequencies" on page 22		
March 2020	007	Added new errata CLX37., CLX38., CLX39. and CLX40.		
December 2019	006	Remove CLX15. Updated CLX11. Add a new erratum and numbered it as CLX15.		
November 2019	005	Added errata CLX33., CLX34., CLX35. and CLX36.		

Date	Revision	Description
September 2019	004	Added errata CLX27., CLX28., CLX29., CLX30., CLX31. and CLX32. Updated Turbo Frequency Tables.
May 2019	003	Added errata CLX21., CLX21., CLX22., CLX23., CLX24., CLX25. and CLX26.
April 2019	002	Added errata CLX18. and CLX19. Made clarifications to Turbo Frequency Tables.
April 2019	001	Initial Release (Intel Public).



Preface

This document is an update to the specifications contained in the next table: Affected Documents. This document is a compilation of device and documentation errata, specification clarifications and changes. It is intended for hardware system manufacturers and software developers of applications, operating systems, or tools.

Information types defined in Nomenclature are consolidated into the specification update and are no longer published in other documents.

This document may also contain information that was not previously published.

Affected Documents

Document Title	Document Number/ Location
2nd Gen Intel [®] Xeon [®] Scalable Processors Datasheet: Volume 1 - Electrical	338845
2nd Gen Intel [®] Xeon [®] Scalable Processors Datasheet: Volume 2 - Registers	338846

Related Documents

Document Title	Document Number/ Location
Intel [®] 64 and IA-32 Architectures Software Developer's Manual Volume 1: Basic Architecture	671436 ¹
Intel [®] 64 and IA-32 Architectures Software Developer's Manual Volume 2A: Instruction Set Reference, A-L	671199 ¹
Intel [®] 64 and IA-32 Architectures Software Developer's Manual Volume 2B: Instruction Set Reference, M-U	671241 ¹
Intel [®] 64 and IA-32 Architectures Software Developer's Manual Volume 3A: System Programming Guide, Part 1	671190 ¹
Intel [®] 64 and IA-32 Architectures Software Developer's Manual Volume 3B: System Programming Guide, Part 2	671427 ¹
ACPI Specifications	www.uefi.org ²

1. Document is available publicly at https://www.intel.com/content/www/us/en/design/resource-design-center.html.

2. Document available at www.uefi.org.

Nomenclature

Errata are design defects or errors. These may cause the Product Name's behavior to deviate from published specifications. Hardware and software designed to be used with any given stepping must assume that all errata documented for that stepping are present on all devices.

S-Spec Number is a five-digit code used to identify products. Products are differentiated by their unique characteristics, such as, core speed, L2 cache size, all notes associated with each S-Spec number.

Specification Changes are modifications to the current published specifications. These changes will be incorporated in any new release of the specification.

Specification Clarifications describe a specification in greater detail or further highlight a specification's impact to a complex design situation. These clarifications will be incorporated in any new release of the specification.

Documentation Changes include typos, errors, or omissions from the current published specifications. These will be incorporated in any new release of the specification.

Note: Errata remain in the specification update throughout the product's lifecycle, or until a particular stepping is no longer commercially available. Under these circumstances, errata removed from the specification update are archived and available upon request. Specification changes, specification clarifications and documentation changes are removed from the specification update when the appropriate changes are made to the appropriate product specification or user documentation (datasheets, manuals, and so on).

Equation 1. Summary Tables of Changes

The following tables indicate the errata, specification changes, specification clarifications, or documentation changes, which apply to the Product Name product. Intel may fix some of the errata in a future stepping of the component, and account for the other outstanding issues through documentation or specification changes as noted. These tables use the following notations:

Codes Used in Summary Tables

Stepping

Page

Status

X:	Errata exists in the stepping indicated. Specification Change or Clarification that applies to this stepping.
(No mark)	
or (Blank box):	This erratum is fixed in listed stepping or specification change does not apply to listed stepping.
(Page):	Page location of item in this document.

Doc: Document change or update will be implemented.

Plan Fix:	This erratum may be fixed in a future stepping of the product.
Fixed:	This erratum has been previously fixed.
No Fix:	There are no plans to fix this erratum.

Row

Change bar to the left of table row indicates this erratum is either new or modified from the previous version of the document.

Errata (Sheet 1 of 3)

Steppings		S	Chattan		
Number	B-1	L-1	R-1	Status	Errata
CLX1.	x	x	x	No Fix	Cache Allocation Technology (CAT)/Code and Data Prioritization (CDP) Might Not Restrict Cacheline Allocation Under Certain Conditions (Intel® Xeon® Processor Scalable Family)
CLX2.	х	x	х	No Fix	Intel® PT PSB+ Packets May be Omitted on a C6 Transition
CLX3.	х	x	x	No Fix	IDI_MISC Performance Monitoring Events May be Inaccurate
CLX4.	x	x	x	No Fix	Intel® PT CYC Packets Can be Dropped When Immediately Preceding PSB
CLX5.	x	x	x	No Fix	Intel PT VM-entry Indication Depends on the Incorrect VMCS Control Field
CLX6.	х	x	х	No Fix	MBA Read After MSR Write May Return Incorrect Value
CLX7.	x	x	x	No Fix	In eMCA2 Mode, When The Retirement Watchdog Timeout Occurs CATERR# May be Asserted
CLX8.	x	x	x	No Fix	VCVTPS2PH To Memory May Update MXCSR in The Case of a Fault on The Store
CLX9.	х	x	х	No Fix	Intel PT May Drop All Packets After an Internal Buffer Overflow
CLX10.	х	x	x	No Fix	Non-Zero Values May Appear in ZMM Upper Bits After SSE Instructions
CLX11.	х	x	x	No Fix	ZMM/YMM Registers May Contain Incorrect Values
CLX12.	x	x	x	No Fix	When Virtualization Exceptions are Enabled, EPT Violations May Generate Erroneous Virtualization Exceptions
CLX13.	x	x	x	No Fix	Intel PT ToPA Tables Read From Non-Cacheable Memory During an Intel TSX Transaction May Lead to Processor Hang
CLX14.	x	x	x	No Fix	Performing an XACQUIRE to an Intel PT ToPA Table May Lead to Processor Hang
CLX15.	x	x	x	No Fix	PCIe* Root Port Does Not Increment REPLAY_NUM on Multiple NAKs of The Same TLP
CLX16.	x	x	x	No Fix	Reading Some C-state Residency MSRs May Result in Unpredictable System Behavior
CLX17.	х	x	x	No Fix	Performance in an 8sg System May Be Lower Than Expected
CLX18.	х	x	x	No Fix	Memory May Continue to Throttle after MEMHOT# De-assertion
CLX19.	х	x	x	No Fix	Unexpected Uncorrected Machine Check Errors May Be Reported
CLX20.	x	x	x	No Fix	CQM Counters May Decrement an Additional Time From During a FwdCode Flow
CLX21.	х	x	х	No Fix	Intel MBM Counters May Double Count
CLX22.	х	x	х	No Fix	Intel MBA May Incorrectly Throttle All Threads
CLX23.	x	x	x	No Fix	Setting Performance Monitoring IA32_PERF_GLOBAL_STATUS_SET MSR Bit 63 May Not #GP
CLX24.	х	x	x	No Fix	Branch Instruction Address May be Incorrectly Reported on TSX Abort When Using MPX
CLX25.	х	x	х	No Fix	x87 FDP Value May be Saved Incorrectly
CLX26.	х	x	х	No Fix	Intel PT Trace May Silently Drop Second Byte of CYC Packet
CLX27.	x	x	x	No Fix	Intel® Speed Select Base Configuration P1 Frequency May Not be Selectable
CLX28.	х	х	х	No Fix	IMC Patrol Scrubbing Engine May Hang
CLX29.	х	x	x	No Fix	Intel MBM Counters May Report System Memory Bandwidth Incorrectly

Errata (Sheet 2 of 3)

	Steppings			C 1-1	Emotion (Contraction)
Number	B-1	L-1	R-1	Status	Errata
CLX30.	х	х	x	No Fix	A Pending Fixed Interrupt May Be Dispatched Before an Interrupt of The Same Priority Completes
CLX31.	x	x	x	No Fix	Voltage/Frequency Curve Transitions May Result in Machine Check Errors or Unpredictable System Behavior
CLX32.	x	x	x	No Fix	Processor May Behave Unpredictably on Complex Sequence of Conditions Which Involve Branches That Cross 64 Byte Boundaries
CLX33.	x	x	x	No Fix	STIBP May Not Function as Intended
CLX34.	x	x	x	No Fix	$Intel^{(\!8\!)}$ UPI, DMI and PCIe Interfaces May See Elevated Bit Error Rates
CLX35.	х	x	x	No Fix	Unexpected Page Faults in Guest Virtualization Environment
CLX36.	x	x	x	No Fix	Instruction Fetch May Cause Machine Check if Page Size Was Changed Without Invalidation
CLX37.	х	х	x	No Fix	Memory Controller May Hang While in Virtual Lockstep
CLX38.	х	х	x	No Fix	MD_CLEAR Operations May Not Properly Overwrite All Buffers
CLX39.	х	х	x	No Fix	ITD Algorithm May Not Select Correct Operating Voltage
CLX40.	x	x	x	No Fix	Direct Branches With Partial Address Aliasing May Lead to Unpredictable System Behavior
CLX41.	x	x	x	No Fix	Runtime Patch Load Enables Processor Capabilities That May Cause Performance Degradation
CLX42.	x	x	x	No Fix	Performance Monitoring General Counter 2 May Have Invalid Value Written When TSX Is Enabled
CLX43.	x	x	x	No Fix	Intel® QuickData Technology Engine May Hang With Any DMA Error if Completion Status is Improperly Set
CLX44.	Х	х	Х	No Fix	Overflow Flag in IA32_MC0_STATUS MSR May be Incorrectly Set
CLX45.	х	х	х	No Fix	A Pending Fixed Interrupt May Be Dispatched Before an Interrupt of The Same Priority Completes
CLX46.	Х	х	Х	No Fix	A Fixed Interrupt May Be Lost When a Core Exits C6
CLX47.	х	х	х	No Fix	A TOR TO may be seen with DDR4 16Gb 2DPC 3DS LRDIMMs with CLX CPU.
CLX48.	х	х	х	No Fix	Certain Errors in Device 16 of a VLS Region Report Device 0 as the Failed Device
CLX49.	х	х	х	No Fix	Memory errors in a VLS region on a certain device may not be properly corrected
CLX50.	Х	Х	Х	No Fix	Processor May Hang if Warm Reset Triggers During BIOS Initialization
CLX51.	х	х	х	No Fix	When in CPGC Mode With Memory Refresh Disabled DDR Scheduler May be Blocked From Issuing CPGC Commands
CLX52.	х	х	х	Fixed	High Levels of Posted Interrupt Traffic on The PCIe Port May Result in a Machine Check With a TOR Timeout
CLX53.	х	х	х	Fixed	Some Short Loops of Instructions May Cause a 3-Strike Machine Check Without a TOR Timeout
CLX54.	х	х	х	Fixed	Processor May Fail to Retry a Write to DDRT Memory
CLX55.	x	x	x	No Fix	Retried PECI PCIConfigLocal Register Accesses May Not Operate Correctly
CLX56.	х	х	х	Fixed	MD_CLEAR Operations May Not Properly Overwrite All Buffers
CLX57.	х	x	x	Fixed	An Incorrect Instruction Pointer May Be Reported for a REP MOVS Instruction
CLX58.	x	x	x	Fixed	Intel® Optane ^{m} Persistent Memory Mode or Mixed Mode May Cause a Hang



Errata (Sheet 3 of 3)

Steppings		Status	Funda		
Number	B-1	L-1	R-1	Status	Errata
CLX59.	х	x	x	No Fix	Systems Using Intel Optane Persistent Memory in Mixed Mode May Experience a System Hang or Reset
CLX60.	х	x	x	No Fix	IA_PERF_LIMIT_REASONS MSR May Not Properly Report Clipping Cause
CLX61.	х	x	x	No Fix	WBINVD/INVD Execution May Result in Unpredictable System Behavior
CLX62.	х	x	x	No Fix	Unexpected Code Breakpoint May Occur
CLX63.	х	х	x	No Fix	Writing Non-Zero Values to Read Only Fields in IA32_THERM_STATUS MSR May Cause a #GP
CLX64.	х	х	x	No Fix	Incorrect MCACOD For L2 MCE
CLX65.	х	x	x	No Fix	Poison Data Reported Instead of a CS Limit Violation
CLX66.	х	х	x	No Fix	Executing Some Instructions May Cause Unpredictable Behavior
CLX67.	х	х	x	No Fix	VERR Instruction Inside VM-entry May Cause DR6 to Contain Incorrect Values
CLX68.	х	x	x	No Fix	System May Hang When The Processor is in 3 Strike Due an Internal Mesh-to- mem Error
CLX69.	х	х	x	No Fix	A PMI That Freezes LBRs Can Cause a Duplicate Entry in TO
CLX70.	х	х	x	No Fix	HWPM Max Ratio May Not be Capped at P1
CLX71.	х	х	x	No Fix	XPT Prefetcher May Not Perform as Expected
CLX72.	х	x	x	No Fix	Call Instruction Wrapping Around The 32-bit Address Boundary May Return to Incorrect Address
CLX73.	х	x	х	No Fix	BSP May Not be The Lowest Numbered APIC ID
CLX74.	х	x	x	No Fix	Accesses to CHA Configuration Space Beyond the CHA Logical Limit May Fail
CLX75.	х	х	x	No Fix	Branch Predictor May Produce Incorrect Instruction Pointer

Specification Changes

Number	Specification Changes			
1	None for this revision of this specification update.			

Specification Clarifications

No.	Specification Clarifications				
1	None for this revision of this specification update.				

Documentation Changes

No.	Documentation Changes
1	None for this revision of this specification update.

Identification Information

Component Identification via Programming Interface

The 2nd Gen Intel[®] Xeon[®] Scalable Processors stepping can be identified by the following register contents:

Reserved	Extended Family ¹	Extended Model ²	Reserved	Processor Type ³	Family Code ⁴	Model Number ⁵	Stepping ID ⁶
31:28	27:20	19:16	15:13	12	11.8	7:4	3.0
	00000000b	0101b		0b	0110b	0101b	Varies per stepping

The Extended Family, bits [27:20] are used in conjunction with the Family Code, specified in bits [11:8], to indicate whether the processor belongs to the Intel386[™], Intel486[™], Pentium[®], Pentium[®] Pro, Pentium[®] 4, Intel[®] Core[™] processor family, or Intel[®] Core[™] i7 family.
 The Extended Model, bits [19:16] in conjunction with the Model Number, specified in bits [7:4], are used to interval the family.

identify the model of the processor within the processor's family. 3. The Processor Type, specified in bit [12] indicates whether the processor is an original OEM processor, an Over

 The Freedom of a dual processor (capable of being used in a dual processor system).
 The Family Code corresponds to bits [11:8] of the Extended Data Register (EDX) after RESET, bits [11:8] of the Extended Accumulator Register (EAX) after the CPUID instruction is executed with a 1 in the EAX register, and the generation field of the Davies ID register eccessible through the Extended Court and the generation field of the Device ID register accessible through Boundary Scan.
5. The Model Number corresponds to bits [7:4] of the EDX register after RESET, bits [7:4] of the EAX register ID

- after the CPUID instruction is executed with a 1 in the EAX register, and the model field of the Device ID register accessible through Boundary Scan.
- 6. The Stepping ID in bits [3:0] indicates the revision number of that model. See Table 1 for the processor stepping ID number in the CPUID information.

When EAX is set to a value of one, the CPUID instruction returns the Extended Family, Extended Model, Processor Type, Family Code, Model Number, and Stepping ID in the EAX register. Note that after reset, the EDX processor signature value equals the processor signature output value in the EAX register.

Cache and TLB descriptor parameters are provided in the EAX, EBX, ECX, and EDX registers after the CPUID instruction is executed with a 2 in the EAX register.

				CAPI	D0 (Segm	ient)	-	ID0 ness)	CAPID4	(Chop)
Physical Chop	Stepping	Segment Wayness	CPUID		B:1,	D:30, F:3,	0:84		B:1, D: O:	
				5	4	3	1	0	7	6
	B-1	Server, 2S	0x50657	1	1	1	0	1	1	1
XCC	B-1	Server, 4S	0x50657	1	1	1	1	0	1	1
	B-1	Server, 8S	0x50657	1	1	1	1	1	1	1
НСС	L-1	Server, 2S	0x50657	1	1	1	0	1	1	0
nee	L-1	Server, 4S	0x50657	1	1	1	1	0	1	0
LCC	R-1	Server, 2S	0x50657	1	1	1	0	1	0	0

Table 1. **Component Identification via Registers**

Non Intel[®] Advanced Vector Extensions (non Intel[®] AVX), Intel[®] Advanced Vector Extensions (Intel[®] AVX), and Intel[®] Advanced Vector Extensions 512 (Intel[®] AVX-512) Turbo Frequencies

Figure 1. 2nd Gen Intel[®] Xeon[®] Scalable Processors Non Intel[®] AVX Turbo Frequencies

											# 0	acti		oroc	1 m	avin		cord	fro	quer		• +···	tho i	mod	~ 10	ш-)						
				Base							# 01	acti	veu	lies	7 11		um		e ne	quei		i tu	001	nou	e (0	12)					1	
SKU	Cores	LLC (MB)	TDP (W)		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
8280	28	38.5	205		4.0	4.0	3.8	3.8	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.5	3.5	3.5	3.5	3.3	3.3	3.3	3.3
8276	28	38.5	165	2.2	4.0	4.0	3.8	3.8	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1	3.0	3.0	3.0	3.0
8270	26	35.75	205	2.7	4.0	4.0	3.8	3.8	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.5	3.5	3.5	3.5	3.4	3.4		
8268	24	35.75	205													_				3.6	_		_				-	-				
8260	24	35.75	165	2.4	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.3	3.3	3.3	3.3	3.1	3.1	3.1	3.1			<u> </u>	
8256	4	16.5	105	3.8	3.9	3.9	3.9	3.9															_								1	
8253	16	22	125	2.2	3.0	3.0	2.8	2.8	2.7	2.7	2.7	2.7	2.7	2.7	2.7	2.7	2.5	2.5	2.5	2.5												
6254	18	24.75	200	3.1	4.0	4.0	3.9	3.9	3.9	3.9	3.9	3.9	3.9	3.9	3.9	3.9	3.9	3.9	3.9	3.9	3.9	3.9									1	
6252	24	35.75	150	2.1	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.2	3.2	3.2	3.2	3.0	3.0	3.0	3.0	2.8	2.8	2.8	2.8				
6248	20	27.5	150	2.5	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.4	3.4	3.4	3.4	3.2	3.2	3.2	3.2								
6246	12	24.75	165	3.3	4.2	4.2	4.1	4.1	4.1	4.1	4.1	4.1	4.1	4.1	4.1	4.1															<u> </u>	
6244	8	24.75	150	3.6	4.4	4.4	4.3	4.3	4.3	4.3	4.3	4.3																			<u> </u>	
6242	16	22	150	2.8	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.5	3.5	3.5	3.5												
6240	18	24.75	150	2.6	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.4	3.4	3.4	3.4	3.3	3.3									<u> </u>	
6238	22	30.25	140	2.1	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1	2.9	2.9	2.9	2.9	2.8	2.8						
6234	8	24.75	130	3.3	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0																				
6230	20	27.5	125	2.1	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.4	3.4	3.4	3.4	3.0	3.0	3.0	3.0	2.8	2.8	2.8	2.8								
6226	12	19.25	125	2.7	3.7	3.7	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5																
5222	4	16.5	105	3.8	3.9	3.9	3.9	3.9																								
5220	18	24.75	125	2.2	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8	2.7	2.7									1	
5218	16	22	125	2.3	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8												
				1							# c	of act	ive o	ore	s/n	naxir	num	cor	e fre	que	ncy i	n tu	rbo	mod	le (G	iHz)						
SKU	Cores	LLC (MB)	TDP (W)	Base non-AVX Core Freq. (GHz)	11	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	2	1 2	2 2	3 2	4 2!	5 26	6 27	28
6262V	24	33	135	1.9	3.6	3.6	5 3.4	3.4	1 3.3	3.3	3.3	3.3	3.2	3.2	3.2	3.2	2.9	2.9	9 2.9	2.9	2.6	5 2.6	5 2.	5 2.	6 2.	5 2.	.5 2.	.5 2.	.5		1	
6222V	20	27.5	115	1.8	3.6	3.6	5 3.4	3.4	1 3.3	3.3	3.3	3.3	2.9	2.9	2.9	2.9	2.6	5 2.6	5 2.6	5 2.6	2.4	2.4	1 2.4	4 2.	4							
6238T	22	30.25	125	1.9	3.7	3.1	3.5	3.5	5 3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.0	3.0	3.0	3.0	2.8	3 2.8	3 2.	3 2.	8 2.	7 2.	.7				1	
6230T	20	27.5	125	2.1	3.9	3.9	3.7	3.7	7 3.6	3.6	3.6	3.6	3.4	3.4	3.4	3.4	3.0	3.0	3.0	3.0	2.8	3 2.8	3 2.	3 2.	8			\top	\top	1	1	
5220T	18	24.75	105	1.9	-	+	+	-	-	-	-	-	-	+	-	-	-	+	-	3 2.8	-	-	-					1	+	+	\top	
5218T	16	22	105	2.1	-	-	-	-	-	-	-	-	-	+	-	-	-	-		2.7	-	1		\top	\top			+	+	+	+	1
4209T	8	11	70	2.2	+	+	-	-) 2.5	-	-	-	+					1				1		\top	\top			T	+	+	\top	1
5220S	18	24.75	125	2.7	-	+	+	-	7 3.6	-	-	-	-	1.	1.		1.				1	1		+	+	+	-	+	+	+	+	1

 8280, 8276, 8260, 6240 and 6138 have 2TB/socket and 4.5TB/socket memory capacity versions (8280M, 8280L, 8276M, 8276L, 8260M, 8260L, 6240M, 6240L, 6138M and 6138L) with identical frequencies.

Figure 2. 2nd Gen Intel[®] Xeon[®] Scalable Processors Intel[®] AVX 2.0 Turbo Frequencies

				_	-	1		-		-	#	of a	ctive	cor	es / I	naxi	mun	or cor	e fre	que	ncy i	n tur	bo n	node	GF	lz)		-		-		-
SKU	Cores	LLC (MB)	TDP (W)	Base AVX 2.0 Core Freq. (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
8280	28	38.5	205	2.2																									2.9			
8276	28	38.5	165	1.7		-			-			-			-	-			-	-	-			-	-		-	-	2.6	-	-	2.6
8270	26	35.75	205	2.2	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.4	3.4	3.4	3.4	3.2	3.2	3.2	3.2	2.9	2.9	2.9	2.9	2.9	2.9		
8268	24	35.75	205	2.4	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.2	3.2	3.2	3.2	3.0	3.0	3.0	3.0				
8260	24	35.75	165	1.9	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.3	3.3	3.3	3.3	3.0	3.0	3.0	3.0	2.7	2.7	2.7	2.7	2.6	2.6	2.6	2.6				
8256	4	16.5	105	3.3	3.7	3.7	3.7	3.7																								
8253	16	22	125	1.7	2.7	2.7	2.5	2.5	2.4	2.4	2.4	2.4	2.2	2.2	2.2	2.2	2.0	2.0	2.0	2.0												
6254	18	24.75	200	2.7	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.4	3.4										
6252	24	35.75	150	1.7	3.6	3.6	3.4	3.4	3.3	3.3	3.3	3.3	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8	2.5	2.5	2.5	2.5	2.4	2.4	2.4	2.4				
6248	20	27.5	150	1.9	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.4	3.4	3.4	3.4	3.0	3.0	3.0	3.0	2.8	2.8	2.8	2.8				\square				
6246	12	24.75	165	2.9	4.0	4.0	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8											\vdash	\square				
6244	8	24.75	150	3.0	4.0	4.0	3.9	3.9	3.9	3.9	3.9	3.9															\vdash					
6242	16	22	150	2.3	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1							\vdash		1			
6240	18	24.75	150	2.0	-	-			-			-			-	-				-	2.8	2.8					\vdash	+				
6238	22	30.25	140	1.7	-	-	-	-	<u> </u>	-		<u> </u>			<u> </u>	<u> </u>			-	-	2.5	-	25	25	25	25	\vdash	\vdash	-		-	
6234	8	24.75	130	2.8	-	-	-		-		3.7	-	0.1	0.1	0.1	0.1	2.0	2.0	2.0	2.0	2.5	2.0	2.0	2.5		2.5	-		-			
6230	20	27.5	125	1.6		-	-		-				2.0	2.0	2.0	2.0	26	26	26	26	2.4	2.4	2.4	24			+	-			-	
6226	12	19.25	125	2.3	-	-			-			-	3.1		-	-	2.0	2.0	2.0	2.0	2.4	2.4	2.4	2.4			-	-	-	-	-	
5222	4	19.25	125	3.3		-			-	5.5	5.5	5.5	5.1	5.1	5.1	5.1			-					-			\vdash	-			-	
-					-	-		3.8	-	2.4	2.4	2.4	2.0	2.0	2.0	2.0	2.6	2.0	2.0	2.6	2.5	2.5		-			\vdash	+		-	-	
5220	18	24.75	125	1.8	-	-	-		-						-	<u> </u>			-	-	2.5	2.5						-			-	
5218	16	22	125	1.8	2.9	2.9	2.7	2.7	2.6	2.6	2.6	2.6	2.5	2.5	2.5	2.5	2.3	2.3	2.3	2.3												
											# c	of act	tive	ore	s / m	naxir	num	core	e fre	que	ncy ii	n tur	bo r	node	e (Gl	Hz)						
				Base																												
SKU	Cores	LLC (MB)	TDP (W)	AVX 2.0 Core Freq. (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
6262V	24	33	135	1.6	3.3	3.3	3.1	3.1	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0	2.8	2.8	2.8	2.8	2.5	2.5	2.5	2.5	2.4	2.4	2.4	2.4				
6222V	20	27.5	115	1.6	3.3	3.3	3.1	3.1	3.0	3.0	3.0	3.0	2.6	2.6	2.6	2.6	2.3	2.3	2.3	2.3	2.2	2.2	2.2	2.2								
6238T	22	30.25	125	1.5	3.6	3.6	3.4	3.4	3.2	3.2	3.2	3.2	2.7	2.7	2.7	2.7	2.4	2.4	2.4	2.4	2.2	2.2	2.2	2.2	2.2	2.2						
6230T	20	27.5	125	1.6	3.8	3.8	3.6	3.6	3.4	3.4	3.4	3.4	2.9	2.9	2.9	2.9	2.6	2.6	2.6	2.6	2.4	2.4	2.4	2.4								
5220T	18	24.75	105	1.5	3.8	3.8	3.6	3.6	3.4	3.4	3.4	3.4	2.9	2.9	2.9	2.9	2.6	2.6	2.6	2.6	2.5	2.5										
5218T	16	22	105	1.7	2.8	2.8	2.6	2.6	2.5	2.5	2.5	2.5	2.4	2.4	2.4	2.4	2.2	2.2	2.2	2.2												
4209T	8	11	70	2.1	3.0	3.0	2.7	2.7	2.1	2.1	2.1	2.1																				

82xx, 62xx, and 52xx Processors

 8280, 8276, 8260, 6240 and 6138 have 2TB/socket and 4.5TB/socket memory capacity versions (8280M, 8280L, 8276M, 8276L, 8260M, 8260L, 6240M, 6240L, 6138M and 6138L) with identical frequencies.



Figure 3. 2nd Gen Intel[®] Xeon[®] Scalable Processors Intel[®] AVX-512 Turbo Frequencies

sku 8280	Core s	LLC		Base	<u> </u>												num			-1C						1	í –					
8280		(MB)	TDP (W)	AVX- 512 Core Freq. (GHz)	1	2	3	4	5	6	7	8	9				13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
	28	38.5	205	1.8																	_			_		_		_	-		2.4	_
8276	28	38.5	165	1.3																											2.1	2.1
8270	26	35.75	205	1.8	-	-			3.4	-							-	-			-	-	<u> </u>	-	-	-	-	-	2.4	2.4		
8268	24	35.75	205	1.9					3.4																							
8260	24	35.75	165	1.5	-	-			3.4	3.4	3.4	3.4	3.0	3.0	3.0	3.0	2.6	2.6	2.6	2.6	2.4	2.4	2.4	2.4	2.3	2.3	2.3	2.3				
8256	4	16.5	105	2.7	-	3.7																										
8253	16	22	125	1.2		-			2.0																							
6254	18	24.75	200	2.2	3.6	3.6	3.4	3.4	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.0	3.0	3.0	3.0	2.9	2.9										
6252	24	35.75	150	1.3	<u> </u>	-			3.0												-	<u> </u>	<u> </u>		2.0	2.0	2.0	2.0	\square			
6248	20	27.5	150	1.6	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.0	3.0	3.0	3.0	2.7	2.7	2.7	2.7	2.5	2.5	2.5	2.5								
6246	12	24.75	165	2.4	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.4	3.4	3.4	3.4																
6244	8	24.75	150	2.6	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5																				
6242	16	22	150	1.9	3.7	3.7	3.5	3.5	3.2	3.2	3.2	3.2	2.7	2.7	2.7	2.7	2.5	2.5	2.5	2.5												
6240	18	24.75	150	1.6	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	2.9	2.9	2.9	2.9	2.6	2.6	2.6	2.6	2.5	2.5										
6238	22	30.25	140	1.3	3.6	3.6	3.4	3.4	3.0	3.0	3.0	3.0	2.6	2.6	2.6	2.6	2.3	2.3	2.3	2.3	2.1	2.1	2.1	2.1	2.1	2.1						
6234	8	24.75	130	2.3	3.7	3.7	3.5	3.5	3.1	3.1	3.1	3.1																				
6230	20	27.5	125	1.1	3.7	3.7	3.5	3.5	2.8	2.8	2.8	2.8	2.4	2.4	2.4	2.4	2.1	2.1	2.1	2.1	2.0	2.0	2.0	2.0								
6226	12	19.25	125	1.9	3.5	3.5	3.3	3.3	3.0	3.0	3.0	3.0	2.6	2.6	2.6	2.6																
5222	4	16.5	105	2.7	3.7	3.7	3.5	3.5																								
5220	18	24.75	125	1.4	3.7	3.7	3.5	3.5	2.8	2.8	2.8	2.8	2.4	2.4	2.4	2.4	2.1	2.1	2.1	2.1	2.1	2.1										
5218	16	22	125	1.5	2.9	2.9	2.7	2.7	2.6	2.6	2.6	2.6	2.3	2.3	2.3	2.3	2.1	2.1	2.1	2.1												
SKU	Cores	LLC (MB)	TDP (W)	Base AVX-512 Core Freq. (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	ximur 13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
6262V	24	33	135	1.1	3.2	3.2	3.0	3.0	2.8	2.8	2.8	2.8	2.4	2.4	2.4	2.4	2.2	2.2	2.2	2.2	2.0	2.0	2.0	2.0	1.9	1.9	1.9	1.9				
6222V	20	27.5	115	1.1	3.0	3.0	2.8	2.8	2.5	2.5	2.5	2.5	2.1	2.1	2.1	2.1	1.9	1.9	1.9	1.9	1.8	1.8	1.8	1.8								
6238T	22	30.25	125	1.1	3.5	3.5	3.3	3.3	2.6	2.6	2.6	2.6	2.2	2.2	2.2	2.2	2.0	2.0	2.0	2.0	1.8	1.8	1.8	1.8	1.8	1.8						
6230T	20	27.5	125	1.1	3.7	3.7	3.5	3.5	2.8	2.8		2.8			2.4	2.4	2.1	2.1	2.1	2.1	2.0	2.0	2.0	2.0								
5220T	18	24.75	105	1.1	3.7	3.7	3.5	3.5	2.8	2.8		2.8			2.4		2.1	2.1	2.1	2.1	2.1								\square			
5218T	16	24.75	105	1.3	2.8	2.8	2.6	2.6	2.5	2.5	2.5	2.5			2.4		2.0	2.0	2.0	2.0									\vdash			
													2.2	2.2	2.2	2.2	2.0	2.0	2.0	2.0					-				\vdash		\vdash	
4209T 5220S	8 18	11 24.75	70 125	1.2	2.0 3.7	2.0 3.7	1.8 3.5	1.8 3.5	1.5 2.8			1.5		2.4			2.1				2.1	2.1							\vdash			

 8280, 8276, 8260, 6240 and 6138 have 2TB/socket and 4.5TB/socket memory capacity versions (8280M, 8280L, 8276M, 8276L, 8260M, 8260L, 6240M, 6240L, 6138M and 6138L) with identical frequencies.

Figure 4.2nd Gen Intel[®] Xeon[®] Scalable Processors Non Intel[®] AVX Turbo Frequencies

											# of	acti	ve c	ores	/ m	axir	num	cor	e fre	que	ncy	in tu	ırbo	mo	de (GHz))					
sku	Cores	LLC (MB)		Base non-AVX Core Frequenc y (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
5220	18	24.75	125	2.2	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8	2.7	2.7										
5218	16	22	125	2.3	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8												
5217	8	11	115	3	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4																				
5215	10	13.75	85	2.5	3.4	3.4	3.2	3.2	3.1	3.1	3.1	3.1	3.0	3.0																		
4216	16	22	100	2.1	3.2	3.2	3.0	3.0	2.9	2.9	2.9	2.9	2.9	2.9	2.9	2.9	2.7	2.7	2.7	2.7												
4215	8	11	85	2.5	3.5	3.5	3.3	3.3	3.0	3.0	3.0	3.0																				
4214	12	16.5	85	2.2	3.2	3.2	3.0	3.0	2.9	2.9	2.9	2.9	2.7	2.7	2.7	2.7																
4210	10	13.75	85	2.2	3.2	3.2	3.0	3.0	2.9	2.9	2.9	2.9	2.7	2.7																		
4208	8	11	85	2.1	3.2	3.2	3.0	3.0	2.5	2.5	2.5	2.5																				
3204	6	8.25	85	1.9	1.9	1.9	1.9	1.9	1.9	1.9																						

- 5215 has 2 TB/socket and 4.5 TB/socket memory capacity versions (5215M and 5215L) with identical frequencies.
- 4214 has an $\rm{Intel}^{\mathbb{R}}$ Speed Select Technology (Intel $^{\mathbb{R}}$ SST) option (4214Y) with identical frequencies.
- All details previously shown are subject to change without notice.

Figure 5. 2nd Gen Intel[®] Xeon[®] Scalable Processors Intel[®] AVX 2.0 Turbo Frequencies

											# of	acti	vec	ores	/m	axir	num	cor	e fre	que	ncy	intu	irbo	mo	de (GHz)					
sku	Cores	ШС (МВ)		Base AVX 2.0 Core Frequency (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
5220	18	24.75	125	1.8	3.8	3.8	3.6	3.6	3.4	3.4	3.4	3.4	2.9	2.9	2.9	2.9	2.6	2.6	2.6	2.6	2.5	2.5										
5218	16	22	125	1.8	2.9	2.9	2.7	2.7	2.6	2.6	2.6	2.6	2.5	2.5	2.5	2.5	2.3	2.3	2.3	2.3												
5217	8	11	115	2.5	3.5	3.5	3.3	3.3	3.0	3.0	3.0	3.0																				
5215	10	13.75	85	2	3.1	3.1	2.9	2.9	2.8	2.8	2.8	2.8	2.6	2.6																		
4216	16	22	100	1.4	3.0	3.0	2.8	2.8	2.7	2.7	2.7	2.7	2.5	2.5	2.5	2.5	2.3	2.3	2.3	2.3												
4215	8	11	85	2	3.3	3.3	3.1	3.1	2.6	2.6	2.6	2.6																				
4214	12	16.5	85	1.8	3.1	3.1	2.9	2.9	2.8	2.8	2.8	2.8	2.4	2.4	2.4	2.4																
4210	10	13.75	85	1.9	3.0	3.0	2.8	2.8	2.5	2.5	2.5	2.5	2.3	2.3																		
4208	8	11	85	1.6	3.0	3.0	2.6	2.6	2.0	2.0	2.0	2.0																				
3204	6	8.25	85	1.5	1.5	1.5	1.5	1.5	1.5	1.5																						

- 5215 has 2 TB/socket and 4.5 TB/socket memory capacity versions (5215M and 5215L) with identical frequencies.
- 4214 has an ${\rm Intel}^{\rm (I\!\!R}$ SST option (4214Y) with identical frequencies
- All details previously shown are subject to change without notice.



Figure 6. 2nd Gen Intel[®] Xeon[®] Scalable Processors Intel[®] AVX-512 Turbo Frequencies

											# of	acti	veo	ores	/ m	axir	num	cor	e fre	que	ncy	in tı	ırbo	moo	de ((GHz)						
sku	Cores	ШС (МВ)		Base AVX-512 Core Frequency (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
5220	18	24.75	125	1.4	3.7	3.7	3.5	3.5	2.8	2.8	2.8	2.8	2.4	2.4	2.4	2.4	2.1	2.1	2.1	2.1	2.1	2.1										
5218	16	22	125	1.5	2.9	2.9	2.7	2.7	2.6	2.6	2.6	2.6	2.3	2.3	2.3	2.3	2.1	2.1	2.1	2.1												
5217	8	11	115	2.0	2.9	2.9	2.7	2.7	2.4	2.4	2.4	2.4																				
5215	10	13.75	85	1.4	2.9	2.9	2.5	2.5	1.9	1.9	1.9	1.9	1.8	1.8																		
4216	16	22	100	1.1	2.0	2.0	1.8	1.8	1.7	1.7	1.7	1.7	1.7	1.7	1.7	1.7	1.6	1.6	1.6	1.6												
4215	8	11	85	1.5	2.3	2.3	2.1	2.1	2.0	2.0	2.0	2.0																				
4214	12	16.5	85	1.3	2.0	2.0	1.8	1.8	1.7	1.7	1.7	1.7	1.6	1.6	1.6	1.6																
4210	10	13.75	85	1.2	2.0	2.0	1.8	1.8	1.6	1.6	1.6	1.6	1.5	1.5																		
4208	8	11	85	1.1	2.0	2.0	1.8	1.8	1.4	1.4	1.4	1.4																				
3204	6	8.25	85	1.0	1.0	1.0	1.0	1.0	1.0	10																					1 1	

- 5215 has 2TB/socket and 4.5TB/socket memory capacity versions (5215M and 5215L) with identical frequencies.
- 4214 has an $Intel^{(R)}$ SST option (4214Y) with identical frequencies.
- All details previously shown are subject to change without notice.

Figure 7. 2nd Gen Intel[®] Xeon[®] Scalable Processors Non Intel[®] AVX Turbo Frequencies

		_									# of	facti	ive c	ores	/ m	axim	um	core	freq	uen	cy in	turl	bo m	ode	(GH	z)						
SKU	Cores	LLC (MB)		Base non-AVX Core Frequency (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
6252N	24	35.75	150	2.3	3.6	3.6	3.4	3.4	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.3	3.2	3.2	3.2	3.2	3.0	3.0	3.0	3.0				
6230N	20	27.5	125	2.3	3.5	3.5	3.3	3.3	3.2	3.2	3.2	3.2	3.2	3.2	3.2	3.2	3.1	3.1	3.1	3.1	2.9	2.9	2.9	2.9								
5218N	16	22	105	2.3	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.3	3.3	3.3	3.3	3.0	3.0	3.0	3.0												
6212U	24	35.75	165	2.4	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.3	3.3	3.3	3.3	3.1	3.1	3.1	3.1				
6210U	20	27.5	150	2.5	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.4	3.4	3.4	3.4	3.2	3.2	3.2	3.2								
6209U	20	27.5	125	2.1	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.4	3.4	3.4	3.4	3.0	3.0	3.0	3.0	2.8	2.8	2.8	2.8							\square	

Figure 8. 2nd Gen Intel® Xeon® Scalable Processors Intel® AVX 2.0 Turbo Frequencies

												# o	f acti	ve cor	res / n	naxim	um o	ore fr	equer	ncy in	turbo	mod	e (GH	z)							
SKU	Cores	LLC (MB)		Base AVX 2.0 Core Frequency (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27
6252N	24	35.75	150	1.8	3.5	3.5	3.3	3.3	3.2	3.2	3.2	3.2	3.2	3.2	3.2	3.2	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8	2.7	2.7	2.7	2.7			
6230N	20	27.5	125	1.6	3.4	3.4	3.2	3.2	3.1	3.1	3.1	3.1	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8	2.6	2.6	2.6	2.6							
5218N	16	22	105	1.6	2.9	2.9	2.8	2.8	2.8	2.8	2.8	2.8	2.8	2.8	2.8	2.8	2.8	2.8	2.8	2.8											
6212U	24	35.75	165	1.9	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.3	3.3	3.3	3.3	3.0	3.0	3.0	3.0	2.7	2.7	2.7	2.7	2.6	2.6	2.6	2.6			
6210U	20	27.5	150	1.9	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.4	3.4	3.4	3.4	3.0	3.0	3.0	3.0	2.8	2.8	2.8	2.8							
6209U	20	27.5	125	1.6	3.8	3.8	3.6	3.6	3.4	3.4	3.4	3.4	2.9	2.9	2.9	2.9	2.6	2.6	2.6	2.6	2.4	2.4	2.4	2.4						1	+

• All details previously shown are subject to change without notice.

Figure 9. 2nd Gen Intel® Xeon® Scalable Processors Intel® AVX-512 Turbo Frequencies

				-								# o	f activ	ve cor	res / n	naxim	um o	ore fr	equer	ncy in	turbo	mod	e (GH	z)							_
sku	Cores	LLC (MB)		Base AVX-512 Core Frequency (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27 2
6252N	24	35.75	150	1.4	3.4	3.4	3.2	3.2	3.1	3.1	3.1	3.1	3.0	3.0	3.0	3.0	2.6	2.6	2.6	2.6	2.4	2.4	2.4	2.4	2.3	2.3	2.3	2.3			
6230N	20	27.5	125	1.2	3.4	3.4	3.2	3.2	3.1	3.1	3.1	3.1	2.6	2.6	2.6	2.6	2.3	2.3	2.3	2.3	2.2	2.2	2.2	2.2							
5218N	16	22	105	1.2	2.9	2.9	2.7	2.7	2.6	2.6	2.6	2.6	2.6	2.6	2.6	2.6	2.5	2.5	2.5	2.5											
																															Τ
6212U	24	35.75	165	1.5	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.0	3.0	3.0	3.0	2.6	2.6	2.6	2.6	2.4	2.4	2.4	2.4	2.3	2.3	2.3	2.3			T
6210U	20	27.5	150	1.6	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.0	3.0	3.0	3.0	2.7	2.7	2.7	2.7	2.5	2.5	2.5	2.5							
6209U	20	27.5	125	1.1	3.7	3.7	3.5	3.5	2.8	2.8	2.8	2.8	2.4	2.4	2.4	2.4	2.1	2.1	2.1	2.1	2.0	2.0	2.0	2.0							T



Figure 10. Intel® Xeon® W-3200 Processors Non Intel® AVX Turbo Frequencies

								-				# of	activ	e co	res	/ ma	axim	num	core	fre	quer	ncy ir	n tu	bon	nod	e (G	Hz)						_
SKU	Cores	LLC (MB)	TDP (W)	Base non-AVX Core Frequency (GHz)	ΙΤΒΜ	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
W-3275	28	38.5	205	2.5	4.6	4.4	4.4	4.2	4.2	4.1	4.1	4.1	4.1	4.1	4.1	4.1	4.1	3.9	3.9	3.9	3.9	3.6	3.6	3.6	3.6	3.3	3.3	3.3	3.3	3.2	3.2	3.2	3.2
W-3265	24	33	205	2.7	4.6	4.4	4.4	4.2	4.2	4.1	4.1	4.1	4.1	4.1	4.1	4.1	4.1	3.9	3.9	3.9	3.9	3.6	3.6	3.6	3.6	3.4	3.4	3.4	3.4				
W-3245	16	22	205	3.2	4.6	4.4	4.4	4.2	4.2	4.1	4.1	4.1	4.1	4.1	4.1	4.1	4.1	3.9	3.9	3.9	3.9												
W-3235	12	19.25	180	3.3	4.5	4.4	4.4	4.2	4.2	4.1	4.1	4.1	4.1	4.0	4.0	4.0	4.0																
W-3225	8	16.5	160	3.7	4.4	4.3	4.3	4.2	4.2	4.2	4.2	4.2	4.2																				
W-3223	8	16.5	160	3.5	4.2	4.0	4.0	3.8	3.8	3.8	3.8	3.8	3.8																				

- The W-3275, W-3265 and W-3245 have 2 TB/socket memory capacity versions (W-3275M, W-3265M and W-3245M) with identical frequencies
- ITBM = Intel[®] Turbo Boost Max Technology 3.0

Figure 11. Intel® Xeon® W-3200 Processors Intel® AVX 2.0 Turbo Frequencies

												#of	activ	e co	res	/m	axim	um	core	fre	quer	icy ir	ntur	bor	nod	e (Gl	Hz)					
SKU	Cores	LLC (MB)	• • •	Base AVX 2.0 Core Frequency (GHz)	ITBM	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27 2
W-3275	28	38.5	205	2.1	N/A	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.3	3.3	3.3	3.3	3.0	3.0	3.0	3.0	2.8	2.8	2.8	2.8	2.7	2.7	2.72
W-3265	24	33	205	2.2	N/A	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.3	3.3	3.3	3.3	3.1	3.1	3.1	3.1	2.9	2.9	2.9	2.9			
W-3245	16	22	205	2.8	N/A	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.2	3.2	3.2	3.2											
W-3235	12	19.25	180	3	N/A	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5															
W-3225	8	16.5	160	3.3	N/A	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8																			
W-3223	8	16.5	160	3	N/A	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5																			

- The W-3275, W-3265 and W-3245 have 2TB/socket memory capacity versions (W-3275M, W-3265M and W-3245M) with identical frequencies
- ITBM = Intel[®] Turbo Boost Max Technology 3.0

Figure 12. Intel® Xeon® W-3200 Processors Intel® AVX-512 Turbo Frequencies

												# of	activ	/e cc	res	/ ma	axin	num	core	efre	quer	ncy ir	ntur	bor	nod	e(G	Hz)						
SKU	Cores	LLC (MB)	TDP (W)	Base AVX-512 Core Frequency (GHz)	ПВМ	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
W-3275	28	38.5	205	1.6	N/A	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.0	3.0	3.0	3.0	2.7	2.7	2.7	2.7	2.5	2.5	2.5	2.5	2.3	2.3	2.3	2.3	2.2	2.2	2.2	2.2
W-3265	24	33	205	1.8	N/A	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8	2.5	2.5	2.5	2.5	2.4	2.4	2.4	2.4				
W-3245	16	22	205	2.3	N/A	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8												
W-3235	12	19.25	180	2.5	N/A	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.0	3.0	3.0	3.0																
W-3225	8	16.5	160	2.8	N/A	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5																				
W-3223	8	16.5	160	2.5	N/A	3.3	3.3	3.1	3.1	3.0	3.0	3.0	3.0																				

 The W-3275, W-3265 and W-3245 have 2 TB/socket memory capacity versions (W-3275M, W-3265M and W-3245M) with identical frequencies.

ITBM = Intel[®] Turbo Boost Max Technology 3.0

Refresh Processors - Non Intel® AVX, Intel® AVX, and Intel® AVX-512 Turbo Frequencies

Figure 13. 2nd Gen Intel® Xeon® Scalable Processors Non Intel® AVX Turbo Frequencies

													# of	active	core	s/ma	ximur	n core	e freq	uency	in tur	bo mo	ode (G	iHz)								
SKU	Cores	LLC (MB)	TDP (W)	Base non-AVX Core Freq. (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
6256	12	33	205	3.6	4.5	4.5	4.3	4.3	4.3	4.3	4.3	4.3	4.3	4.3	4.3	4.3																
6250	8	35.75	185	3.9	4.5	4.5	4.5	4.5	4.5	4.5	4.5	4.5																				
													# of	active	core	s / ma	ximur	n core	e freq	Jency	in tur	bo mo	ode (G	iHz)								
SKU	Cores	LLC (MB)	TDP (W)	Base non-AVX Core Freq. (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
6208U	16	22	150	2.9	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6												
4210T	10	13.75	95	2.3	3.2	3.2	3.0	3.0	2.7	2.7	2.7	2.7	2.5	2.5																		
6258R	28	38.5	205	2.7	4.0	4.0	3.8	3.8	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.6	3.6	3.6	3.6	3.4	3.4	3.4	3.4
6248R	24	35.75	205	3.0	4.0	4.0	3.8	3.8	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.6	3.6	3.6	3.6				
6246R	16	35.75	205	3.4	4.1	4.1	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0												
6242R	20	35.75	205	3.1	4.1	4.1	3.9	3.9	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8					\square			
6240R	24	35.75	165	2.4	4.0	4.0	3.8	3.8	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.4	3.4	3.4	3.4	3.2	3.2	3.2	3.2				
6238R	28	38.5	165	2.2	4.0	4.0	3.8	3.8	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1	3.0	3.0	3.0	3.0
6230R	26	35.75	150	2.1	4.0	4.0	3.8	3.8	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.6	3.6	3.6	3.6	3.3	3.3	3.3	3.3	3.0	3.0	3.0	3.0	3.0	3.0		
6226R	16	22	150	2.9	3.9	3.9	3.7	3.7	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6	3.6												
5220R	24	35.75	150	2.2	4.0	4.0	3.8	3.8	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.7	3.3	3.3	3.3	3.3	3.1	3.1	3.1	3.1	2.9	2.9	2.9	2.9				
5218R	20	27.5	125	2.1	4.0	4.0	3.8	3.8	3.7	3.7	3.7	3.7	3.5	3.5	3.5	3.5	3.1	3.1	3.1	3.1	2.9	2.9	2.9	2.9								
4215R	8	11	130	3.2	4.0	4.0	3.8	3.8	3.6	3.6	3.6	3.6																				
4214R	12	16.5	100	2.4	3.5	3.5	3.3	3.3	3.2	3.2	3.2	3.2	3.0	3.0	3.0	3.0																
4210R	10	13.75	100	2.4	3.2	3.2	3.0	3.0	2.9	2.9	2.9	2.9	2.9	2.9																		
3206R	8	11	85	1.9			1.9					1.9																				

Note: 6250 has a large memory (4.5 TB/Socket) capacity version (6250L) with identical frequencies.



													# of a	octive	core	/ ma	ximun	n core	frea	uency	in tu	rbo m	ode (GHz)								_
SKU	Cores	LLC (MB)	TDP (W)	Base AVX 2.0 Core Frequency (GHz)	1	2	3	4	5	6	7	8			11		13					18			21	22	23	24	25	26	27	28
6256	12	33	205	3.2	L	-	3.8	-	3.8	-		3.8	3.8	3.8	3.8	3.8																
6250	8	35.75	185	3.6	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0																				
																							1.0									_
				Base									# ot a	ctive	cores	/ max	(imun	n core	trequ	lency	in tu	rbo m	ode (GHZJ								
SKU	Cores	LLC (MB)	TDP (W)	AVX 2.0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28
6258R	28	38.5	205	2.3	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.3	3.3	3.3	3.3	3.0	3.0	3.0	3.0	2.9	2.9	2.9	2.
6248R	24	35.75	205	2.5	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.3	3.3	3.3	3.3	3.1	3.1	3.1	3.1				
6246R	16	35.75	205	3.0	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5												
6242R	20	35.75	205	2.7	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.3	3.3	3.3	3.3								
6240R	24	35.75	165	1.9	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.2	3.2	3.2	3.2	3.0	3.0	3.0	3.0				
6238R	28	38.5	165	1.7	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.2	3.2	3.2	3.2	2.9	2.9	2.9	2.9	2.7	2.7	2.7	2.7	2.6	2.6	2.6	2.
6230R	26	35.75	150	1.7	3.8	3.8	3.6	3.6	3.5	3.5	3.5					3.5	-		3.2	3.2	2.9	2.9	2.9	2.9	2.7	2.7	2.7	2.7	2.7	2.7		
6226R	16	22	150	2.3	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1												Γ
6208U	16	22	150	2.3	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1												
5220R	24	35.75	150	1.8	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.2	3.2	3.2	3.2	3.0	3.0	3.0	3.0	2.8	2.8	2.8	2.8				
5218R	20	27.5	125	1.7	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.2	3.2	3.2	3.2	2.9	2.9	2.9	2.9	2.7	2.7	2.7	2.7								
4215R	8	11	130	2.0	3.6	3.6	3.3	3.3	2.6	2.6	2.6	2.6																				
4214R	12	16.5	100	2.1	3.1	3.1	2.9	2.9	2.8	2.8	2.8	2.8	2.7	2.7	2.7	2.7																ſ
4210R	10	13.75	100	2.0	3.0	3.0	2.8	2.8	2.7	2.7	2.7	2.7	2.5	2.5																		
4210T	10	13.75	95	1.9	3.0	3.0	2.8	2.8	2.6	2.6	2.6	2.6	2.4	2.4																		
3206R	8	11	85	1.8	18	18	18	18	1.8	18	1.8	18																				

Figure 14. 2nd Gen Intel® Xeon® Scalable Processors Intel® AVX 2.0 Turbo Frequencies

Note:

6250 has a large memory (4.5 TB/Socket) capacity version (6250L) with identical frequencies.

Figure 15. 2nd Gen Intel® Xeon® Scalable Processors Intel® AVX 512 Turbo Frequencies

													# of	active	e core	s / ma	ximu	m core	e freq	uency	/ in tu	irbo m	node	(GHz)								
SKU	Cores	LLC (MB)	TDP (W	Base AVX-512 Core Frequency (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	2
6256	12	33	205	2.7	3.8	3.8	3.6	3.6	3.5	3.5	3.5	3.5	3.3	3.3	3.3	3.3																
6250	8	35.75	185	3.1	3.8	3.8	3.8	3.8	3.8	3.8	3.8	3.8																				
													# of a	ctive	cores	/ max	imun	n core	frequ	uency	in tu	rbo m	ode (GHz)								
SKU	Cores	LLC (MB)	TDP (W)	Base AVX-512 Core Frequency (GHz)	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	21
5258R	28	38.5	205	1.8	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8	2.6	2.6	2.6	2.6	2.5	2.5	2.5	2.
5248R	24	35.75	205	2	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.3	3.3	3.3	3.3	3.0	3.0	3.0	3.0	2.7	2.7	2.7	2.7	2.6	2.6	2.6	2.6				
5246R	16	35.75	205	2.5	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1												
5242R	20	35.75	205	2.2	3.7	3.7	3.5	3.5	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.4	3.1	3.1	3.1	3.1	2.9	2.9	2.9	2.9								
5240R	24	35.75	165	1.5	3.6	3.6	3.4	3.4	3.3	3.3	3.3	3.3	3.2	3.2	3.2	3.2	2.9	2.9	2.9	2.9	2.6	2.6	2.6	2.6	2.5	2.5	2.5	2.5				
5238R	28	38.5	165	1.3	3.7	3.7	3.5	3.5	3.3	3.3	3.3	3.3	2.9	2.9	2.9	2.9	2.6	2.6	2.6	2.6	2.3	2.3	2.3	2.3	2.2	2.2	2.2	2.2	2.1	2.1	2.1	2.
5230R	26	35.75	150	1.3	3.6	3.6	3.4	3.4	3.3	3.3	3.3	3.3	3.0	3.0	3.0	3.0	2.7	2.7	2.7	2.7	2.5	2.5	2.5	2.5	2.3	2.3	2.3	2.3	2.3	2.3		
5226R	16	22	150	1.9	3.7	3.7	3.5	3.5	3.2	3.2	3.2	3.2	2.7	2.7	2.7	2.7	2.5	2.5	2.5	2.5												
5208U	16	22	150	1.9	3.7	3.7	3.5	3.5	3.2	3.2	3.2	3.2	2.7	2.7	2.7	2.7	2.5	2.5	2.5	2.5												
5220R	24	35.75	150	1.4	3.6	3.6	3.4				3.3	3.3	3.1	3.1	3.1	3.1	2.8	2.8	2.8	2.8	-	2.5		_	2.4	2.4	2.4	2.4				
5218R	20	27.5	125	1.1	3.6	3.6	3.4		3.2		3.2	3.2	2.7	2.7	2.7	2.7	2.5	2.5	2.5	2.5	2.3	2.3	2.3	2.3								
4215R	8	11	130	1.5	3.3						2.0	2.0																				
4214R	12	16.5	100	1.6	2.3	2.3	2.1	2.1		2.0	2.0	2.0	1.9	1.9	1.9	1.9																
4210R	10	13.75	100	1.4	2.2					1.8	1.8	1.8	1.7	1.7																		
4210T 3206R	10 8	13.75 11	95 85	1.2 1.5		3.0 1.5	2.8 1.5	2.8 1.5	2.3 1.5	2.3 1.5	2.3 1.5	2.3 1.5	2.2	2.2																		

Note: 6250 has a large memory (4.5 TB/Socket) capacity version (6250L) with identical frequencies.



Component Marking Information

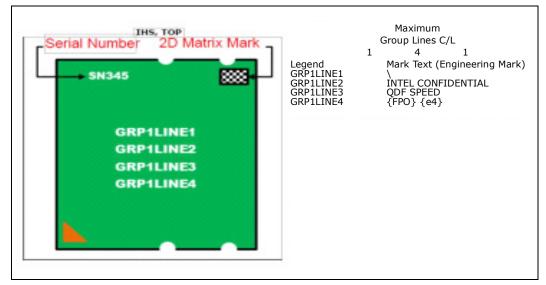


Figure 16. Processor Preliminary Top Side Marking (Example)

The 2nd Gen ${\rm Intel}^{\$}$ Xeon $^{\$}$ Scalable Processors stepping can be identified by the following register markings.

S-Spec Number	Die	Stepping	CPUID	Speed	DDR4 1DPC (MHz)	TDP (W)	# of Cores	Maximum Supported Sockets/Intel [®] UPI Links
SRF9P	XCC	B-1	0x50657	2.7	2933	205	28	8/3
SRF9Q	XCC	B-1	0x50657	2.7	2933	205	28	8/3
SRF9R	XCC	B-1	0x50657	2.7	2933	205	28	8/3
SRF99	XCC	B-1	0x50657	2.2	2933	165	28	8/3
SRF98	XCC	B-1	0x50657	2.2	2933	165	28	8/3
SRF97	XCC	B-1	0x50657	2.2	2933	165	28	8/3
SRF96	XCC	B-1	0x50657	2.7	2933	205	26	8/3
SRF95	XCC	B-1	0x50657	2.9	2933	205	24	8/3
SRF9H	XCC	B-1	0x50657	2.4	2933	165	24	8/3
SRF9F	XCC	B-1	0x50657	2.4	2933	165	24/20/16	8/3
SRF9J	XCC	B-1	0x50657	2.4	2933	165	24	8/3
SRF9G	XCC	B-1	0x50657	2.4	2933	165	24	8/3
SRF94	XCC	B-1	0x50657	3.8	2933	105	4	8/3
SRF93	XCC	B-1	0x50657	2.2	2933	125	16	8/3
SRF92	XCC	B-1	0x50657	3.1	2933	200	18	4 / 3
SRF91	XCC	B-1	0x50657	2.1	2933	150	24	4 / 3
SRF90	XCC	B-1	0x50657	2.5	2933	150	20	4 / 3

Table 2. 2nd Gen Intel[®] Xeon[®] Scalable Processors Identification (Sheet 1 of 2)

S-Spec Number	Die	Stepping	CPUID	Speed	DDR4 1DPC (MHz)	TDP (W)	# of Cores	Maximum Supported Sockets/Intel [®] UPI Links
SRF8Z	XCC	B-1	0x50657	3.6	2933	150	8	4 / 3
SRF8Y	XCC	B-1	0x50657	2.8	2933	150	16	4 / 3
SRF8X	XCC	B-1	0x50657	2.6	2933	150	20	4 / 3
SRF8W	XCC	B-1	0x50657	2.1	2933	125	20	4 / 3
SRF9D	XCC	B-1	0x50657	2.6	2933	85	18/14/8	4 / 3
SRF9C	XCC	B-1	0x50657	1.9	2933	125	22	4 / 3
SRF9A	XCC	B-1	0x50657	2.4	2933	165	24	4 / 3
SRF9B	XCC	B-1	0x50657	2.5	2933	125	20	4 / 3
SRF8V	XCC	B-1	0x50657	3.8	2933	105	4	4 / 2
SRFDJ	XCC	B-1	0x50657	2.3	2666	125	16	4 / 2
SRF8T	XCC	B-1	0x50657	2.3	2666	125	16	4 / 2
SRFBJ	HCC	L-1	0x50657	2.2	2666	125	18	4 / 2
SRFBF	HCC	L-1	0x50657	3.0	2666	115	8	4 / 2
SRFBC	HCC	L-1	0x50657	2.5	2666	85	10	4 / 2
SRFD9	HCC	L-1	0x50657	2.3	2666	105	16	4 / 2
SRFBD	HCC	L-1	0x50657	2.5	2666	85	110	4 / 2
SRFBE	HCC	L-1	0x50657	2.5	2666	85	10	4 / 2
SRFBB	HCC	L-1	0x50657	2.1	2400	100	16	2 / 2
SRFBA	HCC	L-1	0x50657	2.1	2400	85	8	2 / 2
SRFB9	HCC	L-1	0x50657	2.1	2400	100	16	2 / 2
SRFDG	HCC	L-1	0x50657	2.2	2400	85	12/10/8	2 / 2
SRFBQ	LCC	R-1	0x50657	2.2	2400	70	8	2 / 2
SRFBL	LCC	R-1	0x50657	2.2	2400	85	10	2 / 2
SRFBM	LCC	R-1	0x50657	2.1	2400	85	8	2 / 2
SRFBP	LCC	R-1	0x50657	1.9	2133	85	6	2 / 2

Table 2. 2nd Gen Intel[®] Xeon[®] Scalable Processors Identification (Sheet 2 of 2)



Errata

CLX1. Cache Allocation Technology (CAT)/Code and Data Prioritization (CDP) Might Not Restrict Cacheline Allocation Under Certain Conditions (Intel® Xeon® Processor Scalable Family)

- Problem: Under certain microarchitectural conditions involving heavy memory traffic, cache lines might fill outside the allocated L3 Capacity Bitmask (CBM) associated with the current Class of Service (CLOS).
- Implication: Cache Allocation Technology/Code and Data Prioritization (CAT/CDP) might see performance side effects and a reduction in the effectiveness of the CAT feature for certain classes of applications, including cache-sensitive workloads than seen on previous platforms.

Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX2. Intel® PT PSB+ Packets May be Omitted on a C6 Transition

- Problem: An Intel[®] Processor Trace (Intel[®] PT) Packet Stream Boundary+ (PSB+) set of packets may not be generated as expected when IA32_RTIT_STATUS.PacketByteCnt[48:32] (MSR 0x571) reaches the PSB threshold and a logical processor C6 entry occurs within the following one KByte of trace output.
- Implication: After a logical processor enters C6, Intel[®] PT output may be missing PSB+ sets of packets.
- Workaround: None identified.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX3. IDI_MISC Performance Monitoring Events May be Inaccurate

- Problem: The IDI_MISC.WB_UPGRADE and IDI_MISC.WB_DOWNGRADE performance monitoring events (Event FEH; UMask 02H and 04H) counts cache lines evicted from the L2 cache. Due to this erratum, the per logical processor count may be incorrect when both logical processors on the same physical core are active. The aggregate count of both logical processors is not affected by this erratum.
- Implication: IDI_MISC performance monitoring events may be inaccurate.
- Workaround: None identified.
- Status: For the steppings affected, refer to the Summary Tables of Changes.
- CLX4. Intel® PT CYC Packets Can be Dropped When Immediately Preceding PSB
- Problem: Due to a rare microarchitectural condition, generation of an Intel[®] PT PSB packet can cause a single Cycle Count (CYC) packet, possibly along with an associated Mini Time Counter (MTC) packet, to be dropped.
- Implication: An Intel[®] PT decoder that is using CYCs to track time or frequency will get an improper value due to the lost CYC packet.
- Workaround: If an Intel[®] PT decoder is using CYCs and MTCs to track frequency, and either the first MTC following a PSB shows that an MTC was dropped, or the CYC value appears to be 4095 cycles short of what is expected, the CYC value associated with that MTC should not be used. The decoder should wait for the next MTC before measuring frequency again.
- Status: For the steppings affected, refer to the Summary Tables of Changes.



CLX5. Intel PT VM-entry Indication Depends on the Incorrect VMCS Control **Field**

- An Intel[®] PT Paging Information Packet (PIP), which includes indication of entry into Problem: non-root operation, will be generated on VM-entry as long as the "Conceal VMX in Intel® PT″ field (bit 19) in Secondary Execution Control register (IA32_VMX_PROCBASED_CTLS2, MSR 048BH) is clear. This diverges from expected behavior, since this PIP should instead be generated only with a zero value of the "Conceal VMX entries from Intel[®] PT" field (Bit 17) in the Entry Control register (IA32_VMX_ENTRY_CTLS MSR 0484H).
- Implication: An Intel[®] PT trace may incorrectly expose entry to non-root operation.
- A Virtual Machine Monitor (VMM) should always set both the "Conceal VMX entries from Intel[®] PT" field in the Entry Control register and the "Conceal VMX in Intel[®] PT" in the Secondary Execution Control register to the same value. Workaround:
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX6. MBA Read After MSR Write May Return Incorrect Value

- Problem: The Memory Bandwidth Allocation (MBA) feature defines a series of Model Specific Registers (MSRs) (0xD50-0xD57) to specify MBA Delay Values per CLOS, in the IA32 L2 QoS Ext BW Thrtl n MSR range. Certain values when written then read back may return an incorrect value in the MSR. Specifically, values greater than or equal to 10 (decimal) and less than 39 (decimal) written to the MBA Delay Value (Bits [15:0]) may be read back as 10%.
- The values written to the registers will be applied; however, software should be aware Implication: that an incorrect value may be returned.
- Workaround: None identified.
- For the steppings affected, refer to the Summary Tables of Changes. Status:

CLX7. In eMCA2 Mode, When The Retirement Watchdog Timeout Occurs **CATERR# May be Asserted**

- Problem: A Retirement Watchdog Timeout (MCACOD = 0x0400) in Enhanced MCA2 (eMCA2) mode will cause the CATERR# pin to be pulsed in addition to an MSMI# pin assertion. In addition, a Machine Check Abort (#MC) will be pended in the cores along with the MSMI.
- Implication: Due to this erratum, systems that expect to only see MSMI# will also see CATERR# pulse when a Retirement Watchdog Timeout occurs. The CATERR# pulse can be safely ignored.
- Workaround: None identified.
- For the steppings affected, refer to the Summary Tables of Changes. Status:

CLX8. VCVTPS2PH To Memory May Update MXCSR in The Case of a Fault on **The Store**

- Execution of the VCVTPS2PH instruction with a memory destination may update the Problem: MXCSR exceptions flags (bits [5:0]) if the store to memory causes a fault (for example, #PF) or VM exit. The value written to the MXCSR exceptions flags is what would have been written if there were no fault.
- Software may see exceptions flags set in MXCSR, although the instruction has not Implication: successfully completed due to a fault on the memory operation. Intel has not observed this erratum to affect any commercially available software.
- Workaround: None identified.
- Status: For the steppings affected, refer to the Summary Tables of Changes.



CLX9. Intel PT May Drop All Packets After an Internal Buffer Overflow

- Problem: Due to a rare microarchitectural condition, an Intel PT Table of Physical Addresses (ToPA) entry transition can cause an internal buffer overflow that may result in all trace packets, including the Overflow (OVF) packet, being dropped.
- Implication: When this erratum occurs, all trace data will be lost until either PT is disabled and reenabled via IA32_RTIT_CTL.TraceEn [bit 0] (MSR 0570H) or the processor enters and exits a C6 or deeper C state.
- Workaround: None identified.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX10. Non-Zero Values May Appear in ZMM Upper Bits After SSE Instructions

- Problem: Under complex micro architectural conditions, a VGATHER instruction with ZMM16-31 destination register followed by a Server Sent Event (SSE) instruction in the next four instructions, may cause the ZMM register that is aliased to the SSE destination register to have non-zero values in bits 256-511. This may happen only when ZMM0-15 bits 256-511 are all zero, and there are no other instructions that write to ZMM0-15 in between the VGATHER and the SSE instruction. Subsequent SSE instructions that write to the same register will reset the affected upper ZMM bits and XSAVE will not expose these ZMM values as long as no other Intel[®] AVX512 instruction writes to ZMM0-15. This erratum will not occur in software that uses VZEROUPPER between Intel[®] AVX instructions and SSE instructions as recommended in the SDM.
- Implication: Due to this erratum, an unexpected value may appear in a ZMM register aliased to an SSE destination. Software may observe this value only if the ZMM register aliased to the SSE instruction destination is used and VZEROUPPER is not used between Intel[®] AVX and SSE instructions. Intel has not observed this erratum with any commercially available software.

Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX11. ZMM/YMM Registers May Contain Incorrect Values

- Problem: Under complex micro architectural conditions values stored in ZMM and YMM registers may be incorrect.
- Implication: Due to this erratum, YMM and ZMM registers may contain an incorrect value. Intel has not observed this erratum with any commercially available software.

Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX12. When Virtualization Exceptions are Enabled, EPT Violations May Generate Erroneous Virtualization Exceptions

- Problem: An access to a Guest-Physical Address (GPA) may cause an Extended Page Table (EPT)violation VM exit. When the "EPT-violation #VE" VM-execution control is 1, an EPT violation may cause a Virtualization Exception (#VE) instead of a VM exit. Due to this erratum, an EPT violation may erroneously cause a #VE when the "suppress #VE" bit is set in the EPT paging-structure entry used to map the GPA being accessed. This erratum does not apply when the "EPT-violation #VE" VM-execution control is 0 or when delivering an event through the IDT*. This erratum applies only when the GPA in CR3 is used to access the root of the guest paging-structure hierarchy (or, with PAE paging, when the GPA in a PDPTE is used to access a page directory).
- Implication: When using PAE paging mode, an EPT violation that should cause an VMexit in the VMM may instead cause a VE# in the guest. In other paging modes, in addition to delivery of the erroneous #VE, the #VE may itself cause an EPT violation, but this EPT violation will be correctly delivered to the VMM.

Workaround: A VMM may support an interface that guest software can invoke with the VMCALL instruction when it detects an erroneous #VE.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX13. Intel PT ToPA Tables Read From Non-Cacheable Memory During an Intel TSX Transaction May Lead to Processor Hang

- Problem: If an Intel[®] PT ToPA table is placed in Uncacheable (UC) or Uncacheable Speculative Write Combining (USWC) memory, and a ToPA output region is filled during an Intel[®] Transactional Synchronization Extensions (Intel[®] TSX) transaction, the resulting ToPA table read may cause a processor hang.
- Implication: Placing Intel[®] PT ToPA tables in non-cacheable memory when Intel[®] TSX is in use may lead to a processor hang.
- Workaround: None identified. Intel[®] PT ToPA tables should be located in WB memory if Intel[®] TSX is in use.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX14. Performing an XACQUIRE to an Intel PT ToPA Table May Lead to Processor Hang

- Problem: If an XACQUIRE lock is performed to the address of an Intel[®] PT ToPA table, and that table is later read by the CPU during the Hardware Lock Elision (HLE) transaction, the processor may hang.
- Implication: Accessing ToPA tables with XACQUIRE may result in a processor hang.
- Workaround: None identified. Software should not access ToPA tables using XACQUIRE. An OS or hypervisor may wish to ensure all application or guest writes to ToPA tables to take page faults or EPT violations.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX15. PCIe* Root Port Does Not Increment REPLAY_NUM on Multiple NAKs of The Same TLP

- Problem: PCIe Root Port does not increment REPLAY_NUM on a replay initiated by a duplicate NAK for the same Transaction Layer Packet (TLP) and does not retain the Link.
- Implication: If a non-compliant Endpoint NAKs the same TLP repeatedly, the lack of forward progress can lead to (PCIe* Completion, TOR, Internal Timer MCE) timeout.
- Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX16. Reading Some C-state Residency MSRs May Result in Unpredictable System Behavior

Problem: Under complex microarchitectural conditions, an MSR read of MSR_CORE_C3_RESIDENCY MSR (3FCh), MSR_CORE_C6_RESIDENCY MSR (3FCh), or MSR_CORE_C7_RESIDENCY MSR (3FEh) may result in unpredictable system behavior.

Implication: Unexpected exceptions or other unpredictable system behavior may occur.

Workaround: table It is possible for the BIOS to contain a workaround for this erratum.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX17. Performance in an 8sg System May Be Lower Than Expected

- Problem: In 8-socket glueless (8sg) systems, certain workloads may generate a significant stream of accesses to remote nodes, leading to unexpected congestion in the processor's snoop responses.
- Implication: Due to this erratum, 8sg system performance may be lower than expected.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.



Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX18. Memory May Continue to Throttle after MEMHOT# De-assertion

- Problem: When MEMHOT# is asserted by an external agent, the CPU may continue to throttle memory after MEMHOT# de-assertion.
- Implication: When this erratum occurs, memory throttling occurs even after de-assertion of MEMHOT#.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX19. Unexpected Uncorrected Machine Check Errors May Be Reported

Problem: In rare micro-architectural conditions, the processor may report unexpected machine check errors. When this erratum occurs, IA32_MC0_STATUS (MSR 401H) will have the valid bit set (bit 63), the uncorrected error bit set (bit 61), a model specific error code of 03H (bits [31:16]) and an MCA error code of 05H (bits [15:0]).

Implication: Due to this erratum, software may observe unexpected machine check exceptions.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX20. CQM Counters May Decrement an Additional Time From During a FwdCode Flow

Problem: It is possible during a FwdCode flow that the Cache Quality Monitoring (CQM) counter may be decremented an additional time. This scenario would not result in a less than 0 counter.

Implication: Due to this erratum, CQM counters may be lower than expected.

- Workaround: None identified.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX21. Intel MBM Counters May Double Count

- Problem: The Memory Bandwidth Monitoring (MBM) counters (accessible via the IA32_QM_EVTSEL / IA32_QM_CTR MSR pair) may double count when Non-Temporal (NT) writes are used or in remote socket cases. The performance counters in the Integrated Memory Controller (IMC) are not affected and can report the read and write memory bandwidths.
- Implication: For workloads utilizing NT operations the MBM accuracy may be reduced, which can affect performance monitoring or bandwidth-aware scheduling software.
- Workaround: None identified. This erratum can be mitigated by using the IMC performance monitoring counters or per-core performance monitoring counters to derive a read/ write ratio or per-core statistics that can be used to adjust the MBM counters.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX22. Intel MBA May Incorrectly Throttle All Threads

- Problem: When one logical processor is disabled, the MBA feature may select an incorrect MBA throttling value to apply to the core. A disabled logical processor may behave as though the CLOS field in its associated IA32_PQR_ASSOC MSR (0xC8F) is set to zero (appearing to be set to CLOS[0]). When this occurs, the MBA throttling value associated with CLOS[0] may be incorrectly applied to both threads on the core.
- Implication: When Intel[®] Hyper-Threading Technology (Intel[®] HT) is disabled or one logical thread on the core is disabled, the disabled thread is interpreted to have CLOS=0 set in its IA32_PQR_ASSOC MSR by hardware, which affects the calculation for the actual throttling value applied to the core. When this erratum occurs, the MBA throttling value associated with a given core may be incorrect.

- Workaround: To work around this erratum, CLOS[0] should not be used if any logical cores are disabled. Alternately, software may leave all threads enabled.
- Status: For the steppings affected, refer to the Summary Tables of Changes.
- CLX23. Setting Performance Monitoring IA32_PERF_GLOBAL_STATUS_SET MSR Bit 63 May Not #GP
- Problem: Bit 63 of IA32_PERF_GLOBAL_STATUS_SET MSR (391H) is reserved. Due to this erratum, setting the bit will not result in General Protection Fault (#GP).
- Implication: Software that attempts to set bit 63 of IA32_PERF_GLOBAL_STATUS_SET MSR does not generate #GP. There are no other system implications to this behavior.
- Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX24. Branch Instruction Address May be Incorrectly Reported on TSX Abort When Using MPX

- Problem: When using Intel[®] Memory Protection Extensions (Intel[®] MPX), an Intel[®] TSX transaction abort will occur in case of legacy branch (that causes bounds registers INIT) when at least one Intel[®] MPX bounds register was in a NON-INIT state. On such an abort, the branch Instruction address should be reported in the FROM_IP field in the Last Branch Records (LBR), Branch Trace Store (BTS) and Branch Trace Message (BTM) as well as in the Flow Update Packets (FUP) source IP address for Intel[®] PT. Due to this erratum, the FROM_IP field in LBR/BTS/BTM, as well as the FUP source IP address that corresponds to the Intel[®] TSX abort, may point to the preceding instruction.
- Implication: Software that relies on the accuracy of the FROM_IP field / FUP source IP address and uses Intel[®] TSX may operate incorrectly when Intel[®] MPX is used.
- Workaround: None identified.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX25. x87 FDP Value May be Saved Incorrectly

- Problem: Execution of the FSAVE, FNSAVE, FSTENV, or FNSTENV instructions in real-address mode or virtual-8086 mode may save an incorrect value for the x87 FDP (FPU data pointer). This erratum does not apply if the last non-control x87 instruction had an unmasked exception.
- Implication: Software operating in real-address mode or virtual-8086 mode that depends on the FPU Data Pointer (FDP) value for non-control x87 instructions without unmasked exceptions may not operate properly. Intel has not observed this erratum in any commercially available software.
- Workaround: None identified. Software should use the FDP value saved by the listed instructions only when the most recent non-control x87 instruction incurred an unmasked exception.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX26. Intel PT Trace May Silently Drop Second Byte of CYC Packet

- Problem: Due to a rare micro architectural condition, the second byte of a 2-byte CYC packet may be dropped without an OVF packet.
- Implication: A trace decoder may signal a decode error due to the lost trace byte.
- Workaround: None identified. A mitigation is available for this erratum. If a decoder encounters a multi-byte CYC packet where the second byte has bit 0 (Ext) set to 1, it should assume that 4095 cycles have passed since the prior CYC packet, and it should ignore the first byte of the CYC and treat the second byte as the start of a new packet.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

Errata

CLX27. Intel® Speed Select Base Configuration P1 Frequency May Not be Selectable

- Problem: To configure Intel[®] Speed Select, BIOS may program FLEX_RATIO MSR to select the target ratio for Intel[®] Speed Select Configuration 1 or Configuration 2. Programming FLEX_RATIO[15:8] for Intel[®] Speed Select precludes the ability to retrieve the Base Configuration frequency information.
- Implication: If Intel[®] Speed Select Configuration 1 or Configuration 2 is selected, BIOS will not be able to discover the base frequency P1 for Base Configuration from the processor.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX28. IMC Patrol Scrubbing Engine May Hang

Problem: Under rare micro architectural conditions, the processor's IMC Patrol Scrubbing Engine may hang.

Implication: When this erratum occurs, IMC Patrol Scrubbing will cease. Intel has only observed this erratum in a synthetic test environment when testing with high rates of ECC errors.

Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX29. Intel MBM Counters May Report System Memory Bandwidth Incorrectly

Problem: Intel MBM counters track metrics according to the assigned Resource Monitor ID (RMID) for that logical core. The IA32_QM_CTR register (MSR 0xC8E), used to report these metrics, may report incorrect system bandwidth for certain RMID values.

Implication: Due to this erratum, system memory bandwidth may not match what is reported.

- Workaround: It is possible for software to contain code changes to work around this erratum. See the white paper titled Intel[®] Resource Director Technology (Intel[®] RDT) Reference Manual found at https://software.intel.com/en-us/intel-resource-director-technology-rdt-reference-manual for more information.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX30. A Pending Fixed Interrupt May Be Dispatched Before an Interrupt of The Same Priority Completes

- Problem: Resuming from C6 Sleep-State, with Fixed Interrupts of the same priority queued (in the corresponding bits of the IRR and ISR APIC registers), the processor may dispatch the second interrupt (from the IRR bit) before the first interrupt has completed and written to the EOI register, causing the first interrupt to never complete.
- Implication: Due to this erratum, software may behave unexpectedly when an earlier call to an Interrupt Handler routine is overridden with another call (to the same Interrupt Handler) instead of completing its execution.

Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX31. Voltage/Frequency Curve Transitions May Result in Machine Check Errors or Unpredictable System Behavior

- Problem: Under complex micro architectural conditions, during voltage/frequency curve transitions, three-strike machine check errors or other unpredictable system behavior may occur due to an issue in the Fully Integrated Voltage Regulator (FIVR) logic.
- Implication: When this erratum occurs, the system may cause a three-strike machine check error or other unpredictable system behavior.
- Workaround: It is possible for BIOS to contain a workaround for this erratum.



Errata



Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX32. Processor May Behave Unpredictably on Complex Sequence of Conditions Which Involve Branches That Cross 64 Byte Boundaries

Problem: Under complex micro-architectural conditions involving branch instructions bytes that span multiple 64-byte boundaries (cross cache line), unpredictable system behavior may occur.

Implication: When this erratum occurs, the system may behave unpredictably.

Workaround: It is possible for BIOS to contain a workaround for this erratum.

Status: table For the steppings affected, refer to the Summary Tables of Changes.

CLX33. STIBP May Not Function as Intended

- Problem: The Single Thread Indirect Branch Predictors (STIBP) bit (IA32_SPEC_CTL[STIBP] [MSR 48H, bit 1]) prevents the predicted targets of indirect branches on any logical processor of that core from being controlled by software that executes (or executed previously) on another logical processor of the same core. Under specific micro architectural conditions one logical processor may be able to control the predicted targets of indirect branches on the other logical processor even when one of the logical processors has set the STIBP bit.
- Implication: Software relying on STIBP to mitigate against cross-thread speculative branch target injection may allow an attacker running on one logical processor to induce another logical processor on the same core to speculatively execute a disclosure gadget that could reveal confidential data through a side-channel method called Branch Target Injection. This erratum does not affect processors with Hyper-Threading disabled or enabling the cross thread protections of Indirect Branch Restricted Speculation bit (IA32_SPEC_CTL[IBRS] [MSR 48H, bit 0]).

Workaround: It is possible for BIOS to contain a workaround for this erratum.

Status: table For the steppings affected, refer to the Summary Tables of Changes.

CLX34. Intel[®] UPI, DMI and PCIe Interfaces May See Elevated Bit Error Rates

- Problem: The Intel[®] Ultra Path Interconnect (Intel[®] UPI), DMI or PCIe interfaces may be subject to a high bit error rate.
- Implication: Due to this erratum, an elevated rate of packet CRC errors may be observed on these interfaces, which may lead to a Machine Check Error and/or may hang the system.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Workaround: the

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX35. Unexpected Page Faults in Guest Virtualization Environment

- Problem: Under complex micro-architectural conditions, a virtualized guest could observe unpredictable system behavior.
- Implication: When this erratum occurs, systems operating in a Virtualization environment may exhibit unexpected page faults (double faults) leading to guest OS shutdown.
- Workaround: It is possible for BIOS to contain a workaround for this erratum.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX36. Instruction Fetch May Cause Machine Check if Page Size Was Changed Without Invalidation

Problem: This erratum may cause a machine-check error (IA32_MCi_STATUS.MCACOD=005H with IA32_MCi_STATUS.MSCOD=00FH or IA32_MCi_STATUS.MCACOD=0150H with IA32_MCi_STATUS.MSCOD=00FH) on the fetch of an instruction. It applies only if (1) instruction bytes are fetched from a linear address translated using a 4-Kbyte page and



cached in the processor; (2) the paging structures are later modified so that these bytes are translated using a large page (2-Mbyte, 4-Mbyte or 1-GByte) with a different physical address (PA), memory type (PWT, PCD and PAT bits), or User/Supervisor (U/S) bit; and (3) the same instruction is fetched after the paging structure modification but before software invalidates any TLB entries for the linear region.

- Implication: Due to this erratum an unexpected machine check with error code 0150H with MSCOD 00FH may occur, possibly resulting in a shutdown. This erratum could also lead to unexpected correctable machine check (IA32_MCi_STATUS.UC=0) with error code 005H with MSCOD 00FH.
- Workaround: Software should not write to a paging-structure entry in a way that would change the page size and either the physical address, memory type or User/Supervisor bit. It can instead use one of the following algorithms: first clear the P flag in the relevant paging-structure entry (for example, PDE); then invalidate any translations for the affected linear addresses; and then modify the relevant paging-structure entry to set the P flag and establish the new page size. An alternative algorithm: first change the physical page attributes (combination of physical address, memory type and User/Supervisor bit) in all 4K pages in the affected linear addresses; and then modify the relevant paging-structure entry to establish the new page size.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX37. Memory Controller May Hang While in Virtual Lockstep

- Problem: Under complex micro architectural conditions, a memory controller that is in Virtual Lockstep (VLS) may hang on a partial write transaction.
- Implication: The memory controller hangs with a mesh-to-mem timeout Machine Check Exception (MSCOD=20h, MCACOD=400h). The memory controller hang may lead to other machine check timeouts that can lead to an unexpected system shutdown.
- Workaround: It is possible for BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX38. MD_CLEAR Operations May Not Properly Overwrite All Buffers

- Problem: On processors that enumerate the IA32_ARCH_CAPABILITIES.TSX_CTRL MSR bit and are affected by TAA (Intel[®] TSX Asynchronous Abort), the VERW memory instruction should overwrite affected buffers with constant data. On processors also affected by this erratum, VERW may not overwrite upper store buffer data at byte offsets 32–63 of each entry, and may not overwrite upper load port data at byte offsets 32–63 of each port. This behavior may also occur on other MD_CLEAR operations, which overwrite micro architectural structures: specifically the L1D_FLUSH command, and RSM.
- Implication: Software using MD_CLEAR operations to prevent TAA side channel methods from revealing previous accessed data may not prevent those side channel methods from inferring the value of the upper bytes of preceding vector loads or stores.
- Workaround: the .It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX39. ITD Algorithm May Not Select Correct Operating Voltage

- Problem: Implementation of Inverse Temperature Dependency (ITD) compensation may exhibit incorrect voltage compensation under specific voltage and temperature conditions.
- Implication: Due to this erratum, unpredictable system behavior may occur. This erratum has only been observed in a synthetic testing environment at Intel. Intel has not observed this erratum in any commercially available system.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the steppings affected, refer to the Summary Tables of Changes.



CLX40. Direct Branches With Partial Address Aliasing May Lead to Unpredictable System Behavior

Problem: Under complex micro-architectural conditions involving direct branch instructions with partial address aliasing, unpredictable system behavior may occur. Intel has only seen this under synthetic testing conditions. Intel has not observed this under any commercially available software.

Implication: When this erratum occurs, unpredictable system behavior may occur.

Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX41. Runtime Patch Load Enables Processor Capabilities That May Cause Performance Degradation

- Problem: When loading certain microcode updates, some processor capabilities may be inadvertently enabled as part of the patch load procedure. Enabling these capabilities may cause a performance degradation on certain workloads.
- Implication: When this erratum occurs, the process may exhibit unexpected performance degradation. There are no functional implications to this erratum.
- Workaround: It is possible for BIOS to contain a workaround for this issue.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX42. Performance Monitoring General Counter 2 May Have Invalid Value Written When TSX Is Enabled

- Problem: When Intel[®] TSX is enabled, and there are aborts (HLE or RTM) overlapping with access or manipulation of the IA32_PMC2 general-purpose performance counter (Offset: C3h) it may return invalid value.
- Implication: Software may read invalid value from IA32_PMC2.
- Workaround: None workaround identified for the invalid value.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX43. QuickData Technology Engine May Hang With Any DMA Error if Completion Status is Improperly Set

- Problem: If the Intel[®] QuickData Technology Engine (CBDMA) Error Completion Enable register (CHANCTRL.ERR_CMP_EN; CB_BAR Offset 80h; bit 2) is set, but the DMA descriptor's Generate completion status update is not enabled, the CBDMA engine may hang on any DMA error.
- Implication: When this erratum occurs, software using the Intel[®] QuickData Technology Engine may not behave as expected due to a DMA error.
- Workaround: Always enable the Generate completion status update in the DMA descriptor when setting CHANCTRL.ERR_CMP_EN.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX44. Overflow Flag in IA32_MC0_STATUS MSR May be Incorrectly Set

- Problem: Under complex micro architectural conditions, a single internal parity error seen in IA32_MC0_STATUS MSR (401h) with MCACOD (bits 15:0) value of 5h and MSCOD (bits 31:16) value of 7h, may set the overflow flag (bit 62) in the same MSR.
- Implication: Due to this erratum, the IA32_MC0_STATUS overflow flag may be set after a single parity error. Intel has not observed this erratum with any commercially available software.
- Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.



CLX45. A Pending Fixed Interrupt May Be Dispatched Before an Interrupt of The Same Priority Completes

- Problem: Resuming from C6 Sleep-State, with Fixed Interrupts of the same priority queued (in the corresponding bits of the IRR and ISR APIC registers), the processor may dispatch the second interrupt (from the IRR bit) before the first interrupt has completed and written to the EOI register, causing the first interrupt to never complete.
- Implication: Due to this erratum, software may behave unexpectedly when an earlier call to an Interrupt Handler routine is overridden with another call (to the same Interrupt Handler) instead of completing its execution.
- Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX46. A Fixed Interrupt May Be Lost When a Core Exits C6

- Problem: Under complex micro architectural conditions, when performance throttling happens during a core C6 exit, a fixed Interrupt may be lost.
- Implication: Due to this erratum, a fixed interrupt may be lost when internal throttling happens during a core C6 exit. Intel has only observed this erratum in synthetic test conditions.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX47. A TOR TO may be seen with DDR4 16Gb 2DPC 3DS LRDIMMs with CLX CPU.

- Problem: The values for thrt_crit and thrt_hi limits may not be updated for DDR4 16 Gb 3DS LRDIMM 2 DPC. This may lead to an incorrect interpretation of these values, which can lead to a subsequent TOR TO after MRC done.
- Implication: Due to this erratum, A TOR TO may be seen.
- Workaround: None identified.
- Status: No fix. For Cooper Lake was disabled 2X refresh for both 1 DPC and 2 DPC 16 Gb 3 DS LRDIMM and 16 Gb 3 DS RDIMM configurations.

CLX48. Certain Errors in Device 16 of a VLS Region Report Device 0 as the Failed Device

- Problem: Under complex micro architectural conditions, when Adaptive Data Correction (ADC) or Adaptive Double Device Data Correction (ADDDC) is enabled; and is in VLS mode, then if a limited subset of multi-bit errors is detected on primary device 16 in the VLS region, then imc#_c#_retry_rd_err_log_address1.failed_dev logs 0 instead of the actual failing device 16.
- Implication: System Software that takes action based on imc# c# retry rd err log address1.failed dev may implicate the incorrect device.
- Workaround: A workaround for this erratum is available in BIOS. Alternatively, software may detect primary DRAM Device corrected errors [condition by checking if imc[0-2]_c[0-1]_correction_debug_log.adddc_meta_bit_failed (bit 22) is set. If bit 22 is set, the failed device is primary DRAM Device 16, rather than Primary DRAM Device 0.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX49. Memory errors in a VLS region on a certain device may not be properly corrected

Problem: Under complex microarchitectural conditions, when ADC or ADDDC is enabled; and the system has spared out a DRAM device 0,1,3,4,5,8, 13,15 or 16; and is in VLS mode, then if a limited subset of multi-bit errors is detected on primary DRAM device 16 in the VLS region, the error may not be properly corrected.

Implication: The system may experience unpredictable system behavior. Intel has only observed this under synthetic testing conditions.

Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX50. Processor May Hang if Warm Reset Triggers During BIOS Initialization

- Problem: Under complex micro architectural conditions, when the processor receives a warm reset during BIOS initialization, the processor may hang with a machine check error reported in IA32_MCi_STATUS, with MCACOD (bits [15:0]) value of 0400H, and MSCOD (bits [31:16]) value of 0080H.
- Implication: Due to this erratum, the processor may hang. Intel has only observed this erratum in a synthetic test environment.
- Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX51. When in CPGC Mode With Memory Refresh Disabled DDR Scheduler May be Blocked From Issuing CPGC Commands

- Problem: When memory refresh is disabled during Converged Pattern Generation and Checking (CPGC) mode, the IMC scheduler may become blocked from issuing CPGC read and write commands.
- Implication: Due to this erratum, a system hang or continuous restart may occur.
- Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX52. High Levels of Posted Interrupt Traffic on The PCIe Port May Result in a Machine Check With a TOR Timeout

- Problem: High levels of posted interrupt traffic on the PCIe* port may lead to a TOR Timeout Machine Check Exception (MSCOD=000Ch, MCACOD ="Cache Hierarchy Errors") in bank IA32_MC9_STATUS (MSR 425h), IA32_MC10_STATUS (MSR 429h), or IA32_MC11_STATUS (MSR 42Dh).
- Implication: Due to this erratum, the system may hang.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX53. Some Short Loops of Instructions May Cause a 3-Strike Machine Check Without a TOR Timeout

- Problem: Under complex micro architectural conditions, some short loops of instructions may cause a three-strike machine check [(MSCOD=80h, MCACOD=0400h) logged into IA32_MC3_STATUS (MSR 40Dh)] without a TOR timeout. This can only happen when both logical processors on the same physical processor are active.
- Implication: Due to this erratum, the system may hang.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX54. Processor May Fail to Retry a Write to DDRT Memory

Problem: If a system DDR4 memory module asserts ALERT# to signify a transaction error, such as a Command Address Parity error or Write CRC error, the processor may fail to retry a write to DDRT memory. This erratum can only occur in memory configurations that have both DDR4 and DDRT memory in the same channel.

Implication: Due to this erratum, unexpected system behavior may occur.



Workaround: It is possible for the BIOS to contain a workaround for this erratum.

- Status: For the steppings affected, refer to the Summary Tables of Changes.
- CLX55. Retried PECI PCIConfigLocal Register Accesses May Not Operate Correctly
- Problem: When the processor requests a PECI PCIConfigLocal Read or Write command to be retried, and the PECI host immediately retries the command (within 150 us), the processor may fail to correctly process the retried PECI command.
- Implication: Due to this erratum, the PECI PCIConfigLocal Read command may return incorrect data, and the PECI PCIConfigLocal Write command may incorrectly update the target.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX56. MD_CLEAR Operations May Not Properly Overwrite All Buffers

- Problem: On processors that enumerate the MD_CLEAR CPUID bit (CPUID.(EAX=7H,ECX=0): EDX[MD_CLEAR=10]), L1D_FLUSH, RSM, and VERW memory instructions should overwrite affected buffers with constant data. Under complex micro-architectural conditions, these instructions may not overwrite all affected buffers.
- Implication: Due to this erratum, the use of MD_CLEAR operations to prevent MDS (Microarchitectural Data Sampling) or TAA (Intel[®] Transactional Synchronization Extensions Asynchronous Abort) side-channel methods from revealing previously accessed data may not be fully effective.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.
- CLX57. An Incorrect Instruction Pointer May Be Reported for a REP MOVS Instruction
- Problem: When a REP MOVS instruction reports a Software Recoverable Action Required (SRAR) error for memory that software did not intend to access, the instruction pointer is reported incorrectly on the thread where RIPV/EIPV=1.
- Implication: Due to this erratum, the processor may report SRAR errors with an incorrect instruction pointer.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.
- CLX58. Intel® Optane[™] Persistent Memory Mode or Mixed Mode May Cause a Hang
- Problem: When the processor is utilizing Intel[®] Optane[™] Persistent Memory Mode or Mixed Mode, a Core MMIO read request may incorrectly block a write request from the IO subsystem, leading to a system hang.
- Implication: Due to this erratum, the processor may hang with a Table Of Requests (TOR) timeout reported in Machine Check Banks 9, 10, or 11 in the MCi_STATUS MSR's (425h, 429h, or 42Dh) with an MSCOD (bits [31:16]) value of 000Ch.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX59. Systems Using Intel Optane Persistent Memory in Mixed Mode May Experience a System Hang or Reset

Problem: When the processor is utilizing Intel Optane persistent memory in Mixed Mode with both App Direct and Memory Mode Snoopy Modes enabled, a system hang or reset may occur when running a workload.

- Implication: Due to this erratum, the system may reset or hang, logging an Internal Timer Error in MC3_STATUS MSR (40Dh) with MSCOD (bits[31:16]) value of 0080h and MCACOD (bits[15:0]) value of 0400h or logging a Table Of Requests (TOR) Timeout in MCi_STATUS MSRs (425h, 429h, or 42Dh) with an MSCOD value of 000Ch.
- Workaround: None identified. Systems can avoid this erratum by not using Mixed Mode with both App Direct and Memory Mode Snoopy Modes enabled.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX60. IA_PERF_LIMIT_REASONS MSR May Not Properly Report Clipping Cause

- Problem: The VR_THERM_ALERT_LOG (bit 22) and VR_THERM_ALERT_STATUS (bit 6) fields in IA_PERF_LIMIT_REASONS MSR (64Fh) do not log a VR_HOT event. In addition, the associated PERFMON event VR_HOT_CYCLES (42h) does not increment upon VR_HOT events.
- Implication: Due to this erratum, software may not be able to determine whether frequency clipping is due to VR_HOT events.
- Workaround: None identified.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX61. WBINVD/INVD Execution May Result in Unpredictable System Behavior

- Problem: Under complex micro architectural conditions, the processor may hang or exhibit unpredictable system behavior during Writeback and Invalidate Cache (WBINVD) or Invalidate Internal Caches (INVD) cache instruction execution on a two or more socket system.
- Implication: When this erratum occurs, the processor may hang reporting an Internal Timer Error in MCi_STATUS MSRs (40Dh, 411h) with MSCOD (bits[31:16]) value of 0080h and MCACOD (bits[15:0]) value of 0400h, or reporting a Table Of Requests (TOR) Timeout in MCi_STATUS MSRs (425h, 429h, or 42Dh) with an MSCOD value of 000Ch. or may exhibit unpredictable system behavior. Intel has only observed this erratum in a synthetic test environment.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX62. Unexpected Code Breakpoint May Occur

- Problem: An unexpected code breakpoint may occur in one logical thread on a physical core while another logical thread on the same physical core is performing a Branch Prediction Unit Flush (MSR 0x49, bit [0] set to 1).
- Implication: Due to this erratum, the processor may take an unexpected code breakpoint exception. Software that is not configured to manage such an exception may not operate as expected.
- Workaround: the It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX63. Writing Non-Zero Values to Read Only Fields in IA32_THERM_STATUS MSR May Cause a #GP

- Problem: IA32_THERM_STATUS MSR (19CH) includes read-only (RO) fields as well as writable fields. Writing a non-zero value to any of the read-only fields may cause a #GP.
- Implication: Due to this erratum, software that reads the IA32_THERM_STATUS MSR, modifies some of the writable fields, and attempts to write the MSR back may cause a #GP.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the steppings affected, refer to the Summary Tables of Changes.



Errata

CLX64. Incorrect MCACOD For L2 MCE

Problem: Under complex micro architectural conditions, an L2 poison MCE that should be reported with MCACOD 189h in IA32_MC3_STATUS MSR (MSR 40dh, bits [15:0]) may be reported with an MCACOD of 101h.

Implication: Due to this erratum, the reported MCACOD for this MCE may be incorrect.

Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX65. Poison Data Reported Instead of a CS Limit Violation

- Problem: Under complex micro architectural conditions, in case of poisoned data on an address that violates the CS (code segment) limit, a poison MCE may be signaled and logged in IA32_MC0_STATUS MSR (MSR 401H, MCACOD 150h) instead of CS limit violation.
- Implication: Due to the erratum, the processor may signal an MCE rather than a higher-priority CS limit violation.
- Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX66. Executing Some Instructions May Cause Unpredictable Behavior

- Problem: Under complex micro architectural conditions, executing an X87, Intel[®] Advanced Vector Extensions (Intel[®] AVX), or integer divide instruction may result in unpredictable system behavior.
- Implication: When this erratum occurs, the system may behave unpredictably. Intel has not observed this erratum with any commercially available software.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX67. VERR Instruction Inside VM-entry May Cause DR6 to Contain Incorrect Values

- Problem: Under complex micro architectural conditions, a VERR instruction that follows a VMentry with a guest-state area indicating MOV SS blocking (bit 1 in the Interruptibility state) and at least one of B3-B0 bits set (bits 3:0 in the pending debug exception) may lead to incorrect values in DR6.
- Implication: Due to this erratum, DR6 may contain incorrect values. Intel has not observed this erratum with any commercially available software.
- Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX68. System May Hang When The Processor is in 3 Strike Due an Internal Mesh-to-mem Error

Problem: Under complex micro architectural conditions, the processor may hang with an error mesh-to-mem caused by a core 3-strike with Machine Check Exception (MSCOD=80h, MCACOD=0400h) logged into IA32_MC3_STATUS (MSR 40Dh).

Implication: Due to this erratum, the system may hang.

Workaround: It is possible for the BIOS to contain a workaround for this erratum.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX69. A PMI That Freezes LBRs Can Cause a Duplicate Entry in TO

Problem: If a Performance Monitor Interrupt (PMI) is taken while Last Branch Records (LBRs) are enabled and IA32_DEBUGCTL.FREEZE_LBRS_ON_PMI[bit 11]=1 (MSR 01D9H), a taken



branch that performs an LBR update near the time of the PMI may instead record a duplicate of the prior entry into the Top of Stack (TOS) entry.

- **Implication:** Software may unexpectedly observe the appearance of back-to-back execution of the same branch. In general, software can ignore the TOS entry if it matches the TOS-1 entry. Note that certain code sequences with no intervening taken branches can legitimately insert a valid duplicate LBR record in the TOS entry.
- Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX70. HWPM Max Ratio May Not be Capped at P1

- Problem: The platform may be granted a ratio higher than the guaranteed ratio (P1) when the Energy Efficient Turbo Disable bit (19) in the POWER_CTL1 MSR is set to 1h if a ratio higher than P1 is requested in HWPM (Hardware Power Management) OOB (Out of Band) mode.
- Implication: Due to this erratum, Turbo mode disable may not be enforced for HWPM. Intel has not observed any functional failures due to this erratum.
- Workaround: None identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX71. XPT Prefetcher May Not Perform as Expected

- Problem: When XPT prefetcher is enabled it may not prefetch as expected on memory channels that contain Intel[®] Optane[™] Persistent Memory.
- Implication: Due to this erratum, the XPT prefetcher may not perform as expected.

Workaround: None Identified.

Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX72. Call Instruction Wrapping Around The 32-bit Address Boundary May Return to Incorrect Address

- Problem: In 32-bit mode, a call instruction wrapping around the 32-bit address must save a return address near the bottom of the address space (low address) around address zero. Under complex micro-architectural conditions, a return instruction following such a call may return to the next sequential address instead (high address).
- Implication: Due to this erratum, in 32-bit mode, a return following a call instruction that wraps around the 32-bit address boundary may return to the next sequential IP without wrapping around the address, possibly resulting in a #PF. Intel has not observed this behavior on any commercially available software.
- Workaround: Software should not place call instructions in addresses that wrap around the 32-bit address space in 32-bit mode.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX73. BSP May Not be The Lowest Numbered APIC ID

- Problem: The Advanced Programmable Interrupt Controller (APIC) ID numbering may not assign the Boot Strap Processor (BSP) to the lowest numbered APIC ID.
- Implication: Due to this erratum, system software that relies on BSP to be the lowest numbered APIC ID may not function as expected.
- Workaround: None identified. Software that expects the BSP to be the lowest numbered APIC ID should save and restore the BSP APIC ID when entering and exiting S3.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX74. Accesses to CHA Configuration Space Beyond the CHA Logical Limit May Fail

- Problem: The processor may have more Caching and Home Agent (CHA) physically implemented than are logically available in the processor. CHA configuration registers are located in PCIe configuration space associated with the CHA bus, device, and function, with the first CHA being located at Bus1, Device 8, Function 0 AND also BUS 1, Device14, Function0. There are 2 functions in PCI Configuration (CFG) space for each CHA. Accesses to CHA configuration space may not return valid results for BDFs beyond the number of logical CHAs supported in the processor as enumerated in CAPID6 (Bus 1, Device 30, Function 3, Offset 9Ch, bits [27:0]).
- Implication: Due to this erratum, accesses to CHA configuration spaces, including Device ID, for CHAs beyond the CHA logical limit may not return valid results.
- Workaround: None identified. Software must not rely upon CHA configuration space for CHAs beyond the logic limit of the processor.
- Status: For the steppings affected, refer to the Summary Tables of Changes.

CLX75. Branch Predictor May Produce Incorrect Instruction Pointer

- Problem: Under complex microarchitectural conditions, the branch predictor may produce an incorrect instruction pointer leading to unpredictable system behavior.
- Implication: Due to this erratum, the system may exhibit unpredictable behavior.
- Workaround: It is possible for the BIOS to contain a workaround for this erratum.
- Status: For the steppings affected, refer to the Summary Tables of Changes.



Specification Changes

There are no Specification Clarifications in this Specification Update revision.



Specification Clarifications

There are no specification clarifications in this revision of the specification update.

Documentation Changes

There are no documentation changes in this revision of the specification update.